



# SCHEMATIC DIAGRAMS

## POWERED WOOFER CD SYSTEM

RV-NB70BA  
RV-NB70BJ

RV-NB70BE  
RV-NB70SE  
RV-NB70SJ

RV-NB70BEY  
RV-NB70SEY

## ■ PRECAUTIONS ON SCHEMATIC DIAGRAMS

- Due to the improvement in performance, some part numbers shown in the circuit diagrams may not agree with those indicated in the Parts List.
- The parts numbers, values and rated voltage etc. in the Schematic Diagrams are for reference only.
- Since the circuit diagrams are standard ones, the circuits and circuit constants may be subject to change for improvement without any notice.

## ■ PRECAUTIONS ON PARTS LIST

- The parts identified by the  $\triangle$  symbol are critical for safety. Whenever replacing these parts, be sure to use specified ones to secure the safety.
- The parts not indicated in this Parts List and those which are filled with lines --- in the Parts No. columns will not be supplied.
- P.W. BOARD Ass'y will not be supplied, but those which are filled with the Parts No. in the Parts No. columns will be supplied.
- When ordering chips, screws etc., place bulk orders (unit of tens) whenever possible to improve shipping efficiency.
- There are cases where the actual implemented parts in the sets and the service parts are different. When ordering parts, make sure to refer to the Parts List.

## ■ PRECAUTIONS ON SERVICE

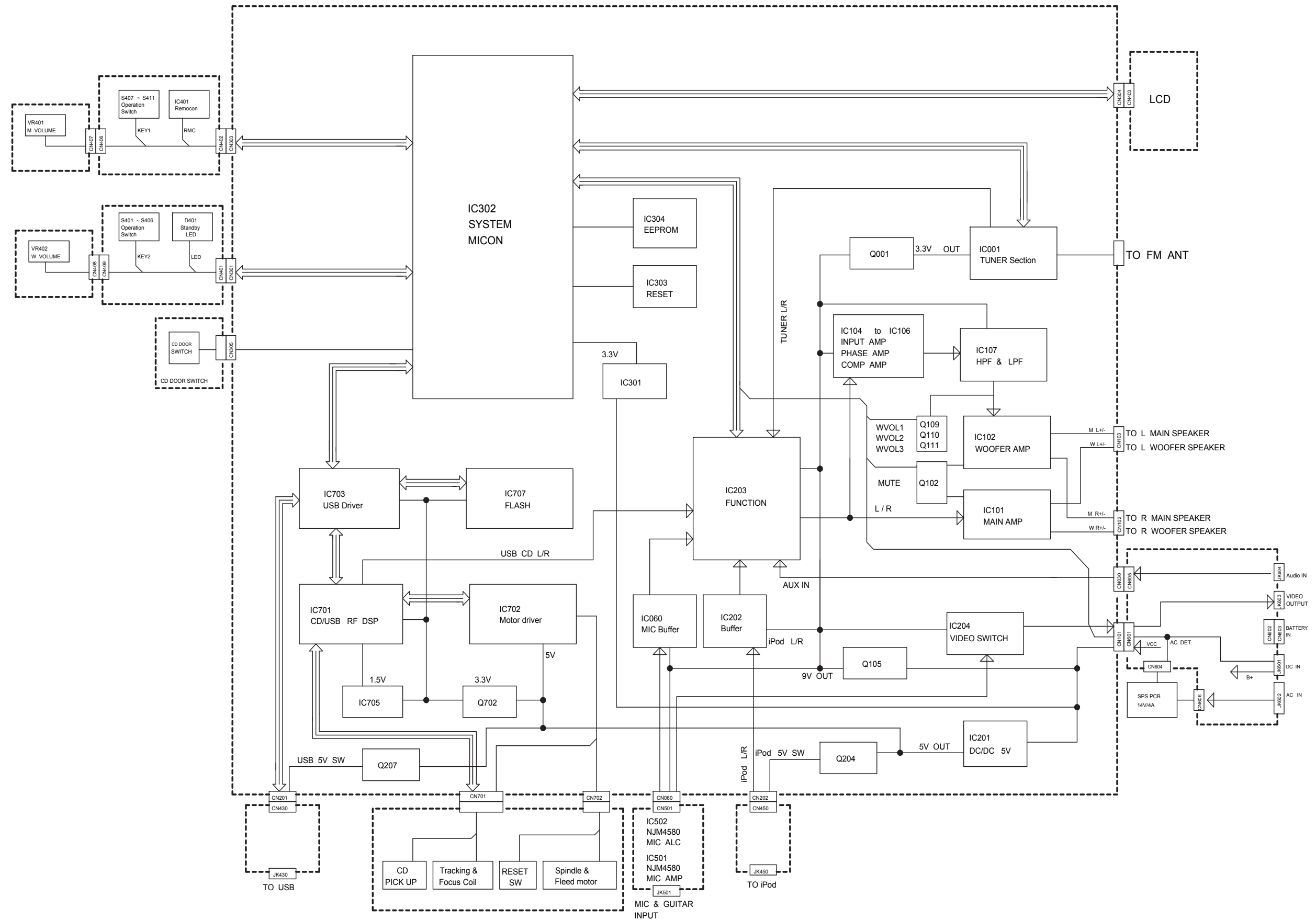
Certain parts of the power circuits and the GNDs differ according to the models. Care must be taken for the following points as the differences are indicated separately in the LIVE GND ( $\downarrow$ ) and the ISOLATED (NEUTRAL) GND ( $\perp$ ).

1. Do not touch the LIVE GND, or do not touch the LIVE GND and the ISOLATED (NEUTRAL) GND at the same time. It may cause an electric shock.  
Before pulling out the chassis or other parts, make sure to pull out the power cord from the wall outlet first.
2. Do not short circuit between the LIVE GND and ISOLATED (NEUTRAL) GND, or never measure the LIVE GND and ISOLATED (NEUTRAL) GND at the same time using measuring instruments (oscilloscope, etc.). It may blow fuses or damage other parts.

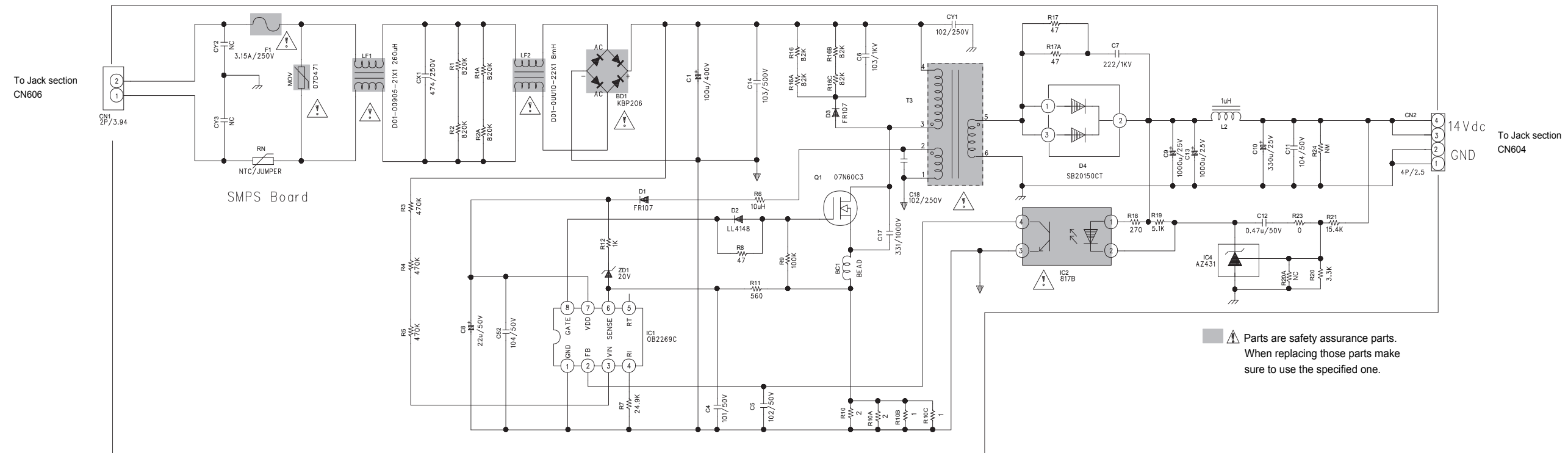
## ■ DEVIATION TOLERANCE RANGE

DEVIATION TOLERANCE RANGE									
F	G	J	K	M	N	R	H	Z	P
$\pm 1\%$	$\pm 2\%$	$\pm 5\%$	$\pm 10\%$	$\pm 20\%$	$\pm 30\%$	+30% -10%	+50% -10%	+80% -20%	+100% -0%

# Block diagram

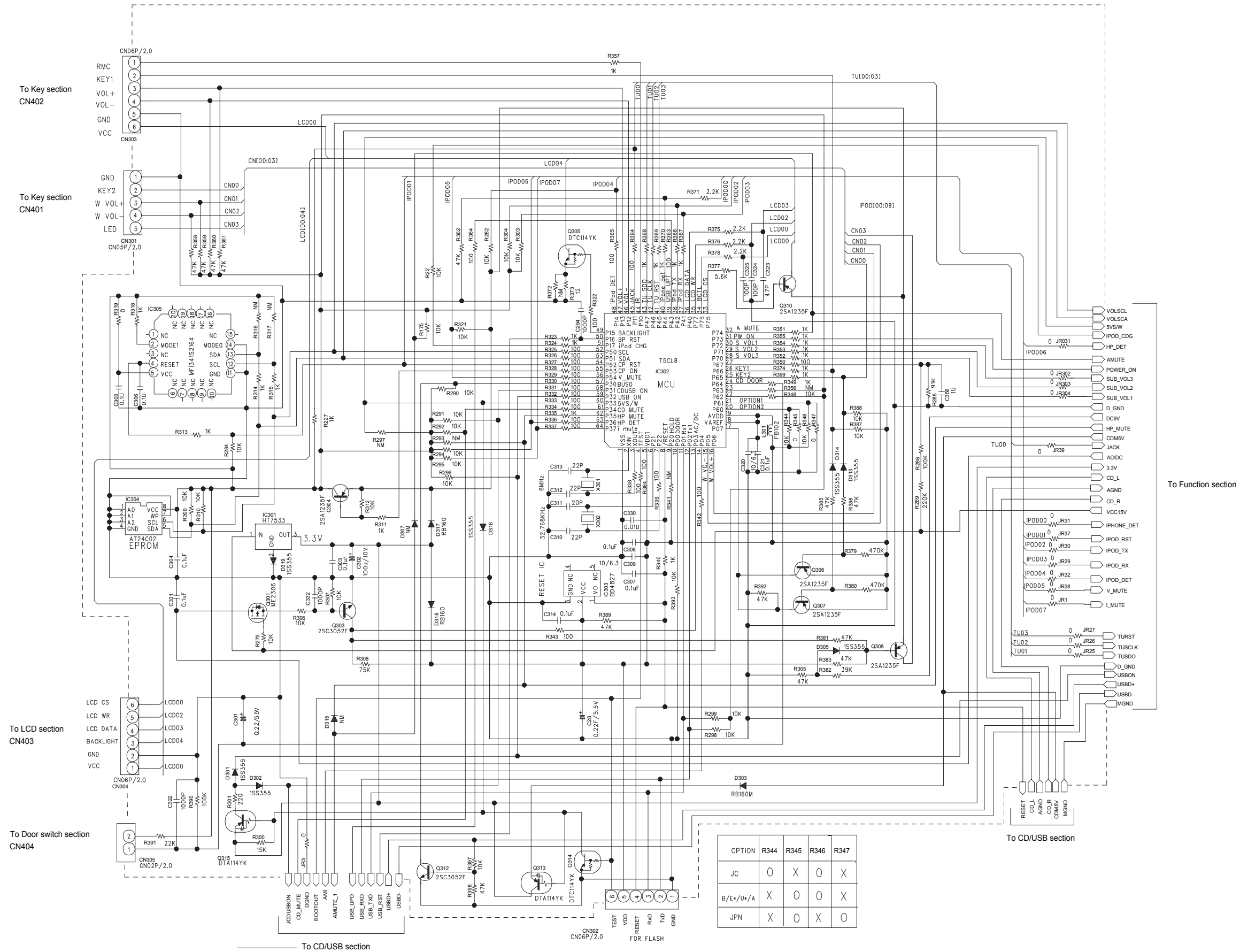


<SMPS section>

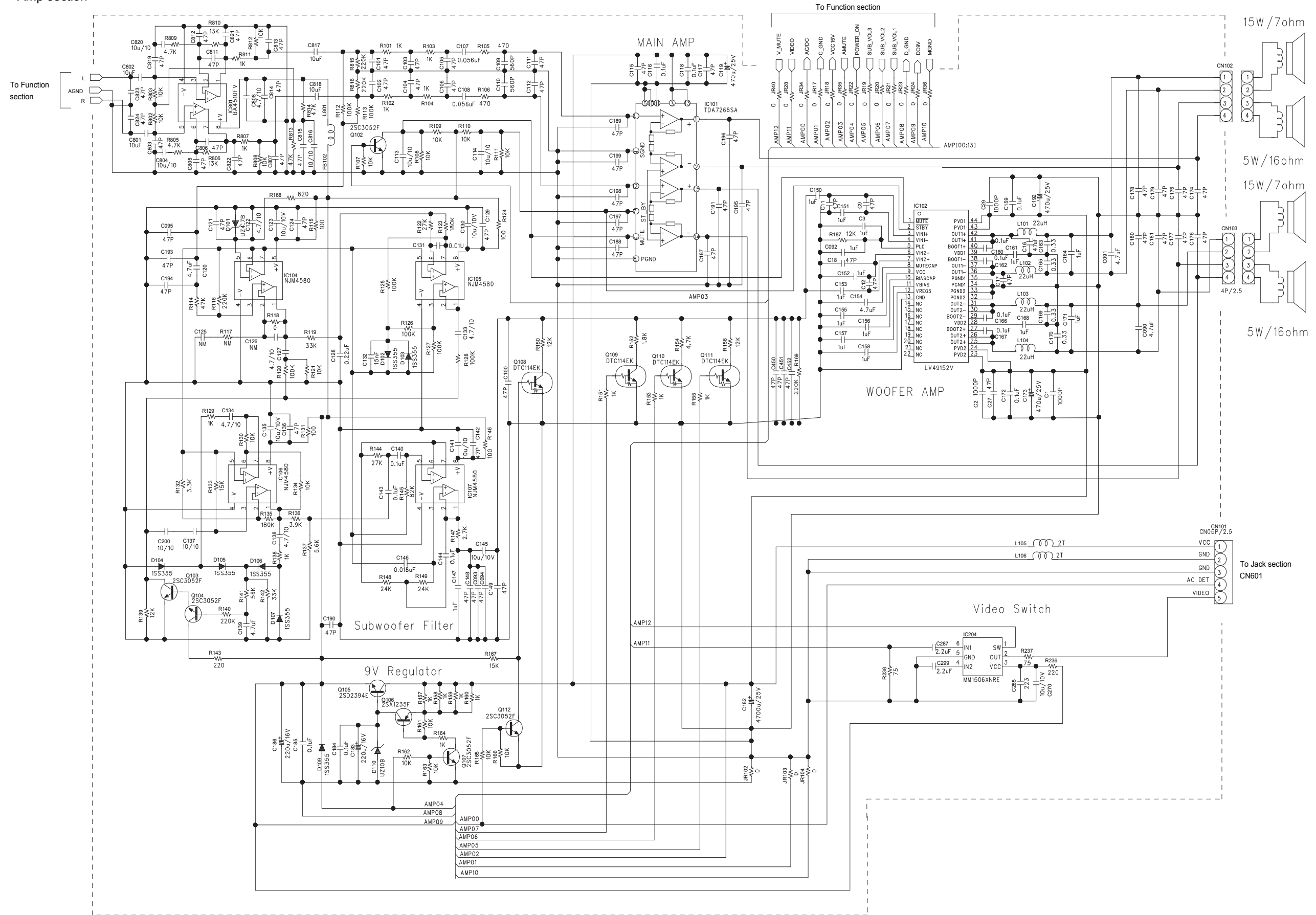




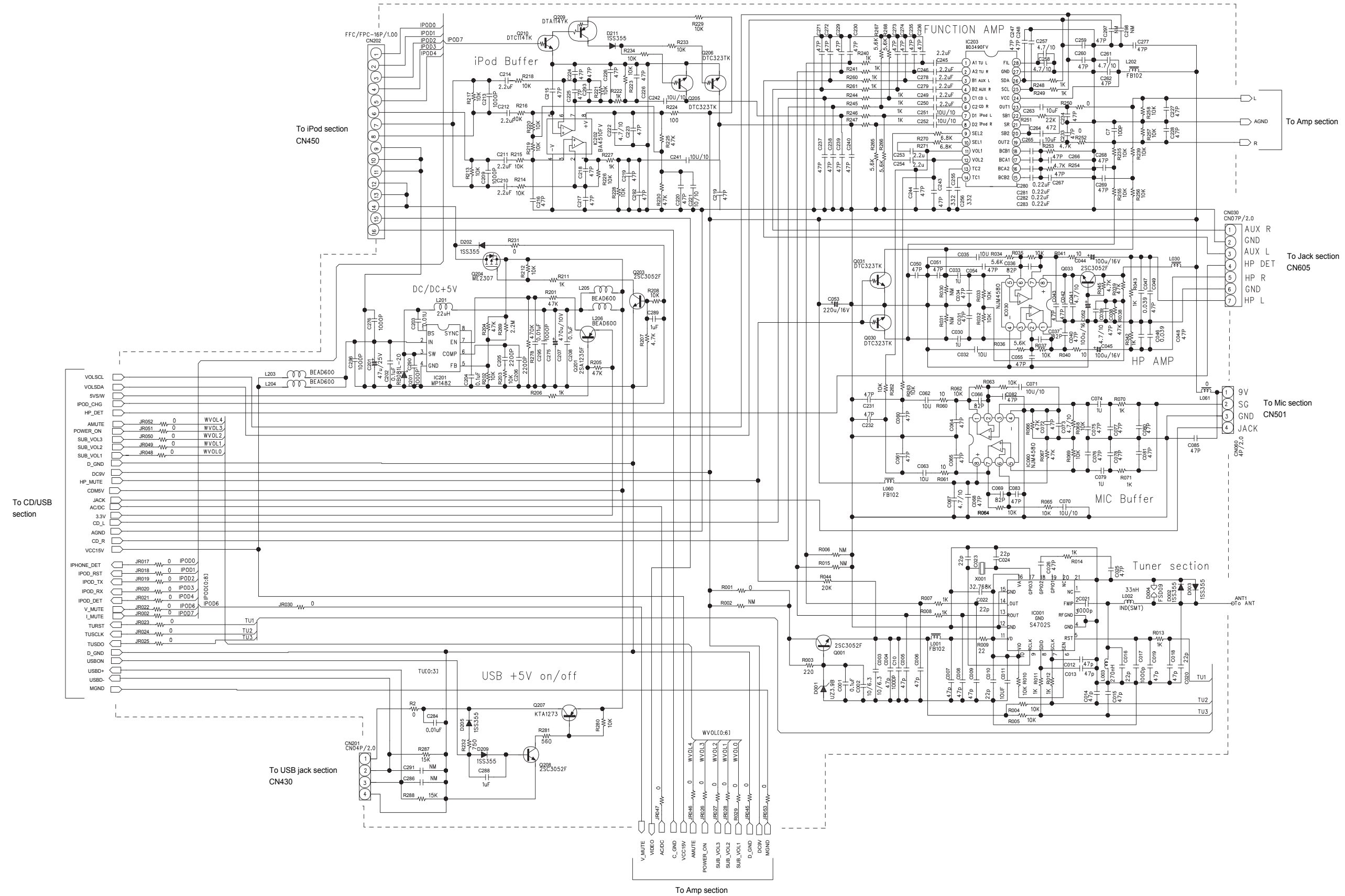
<Micom section>



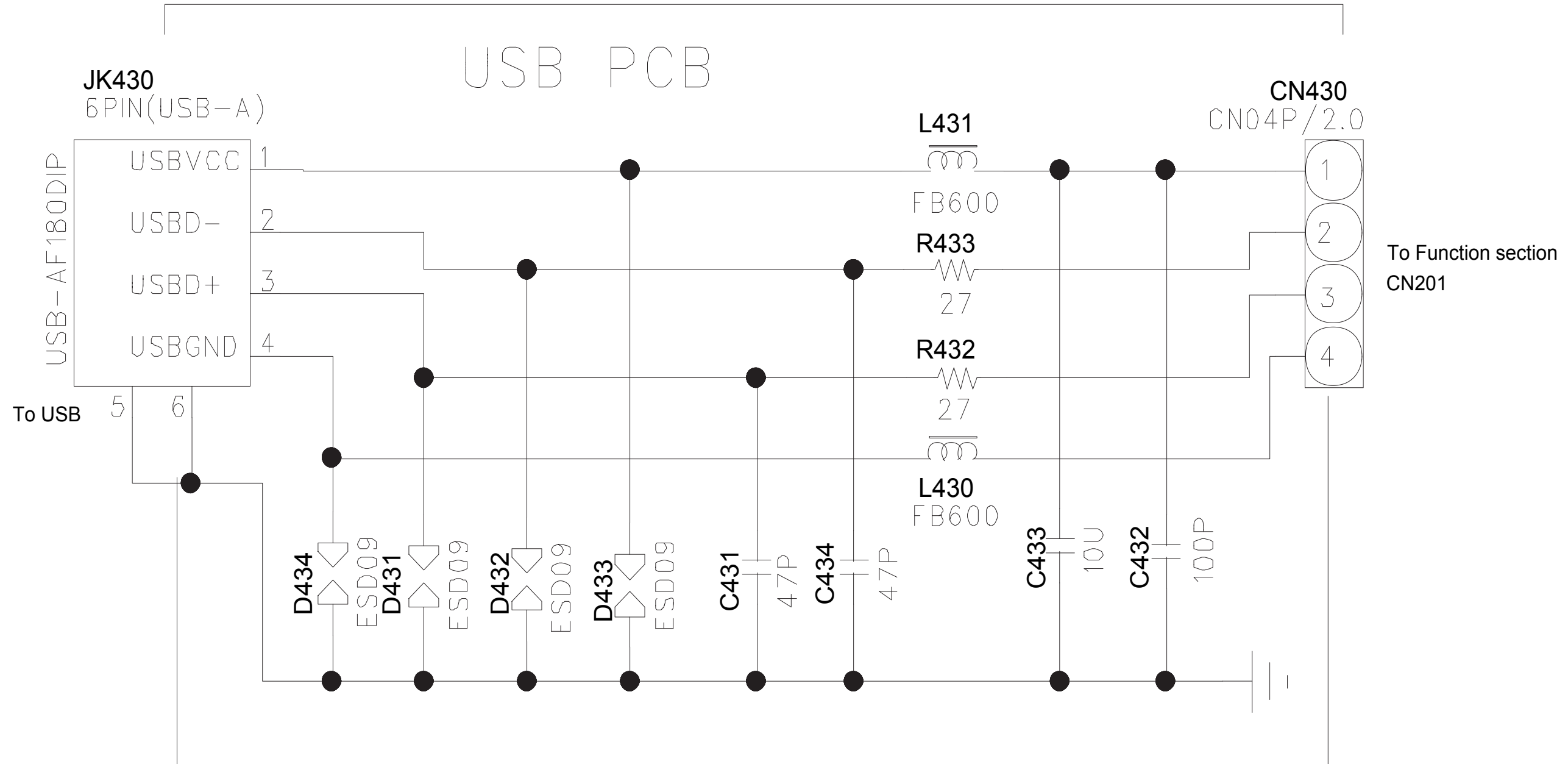
<Amp section>



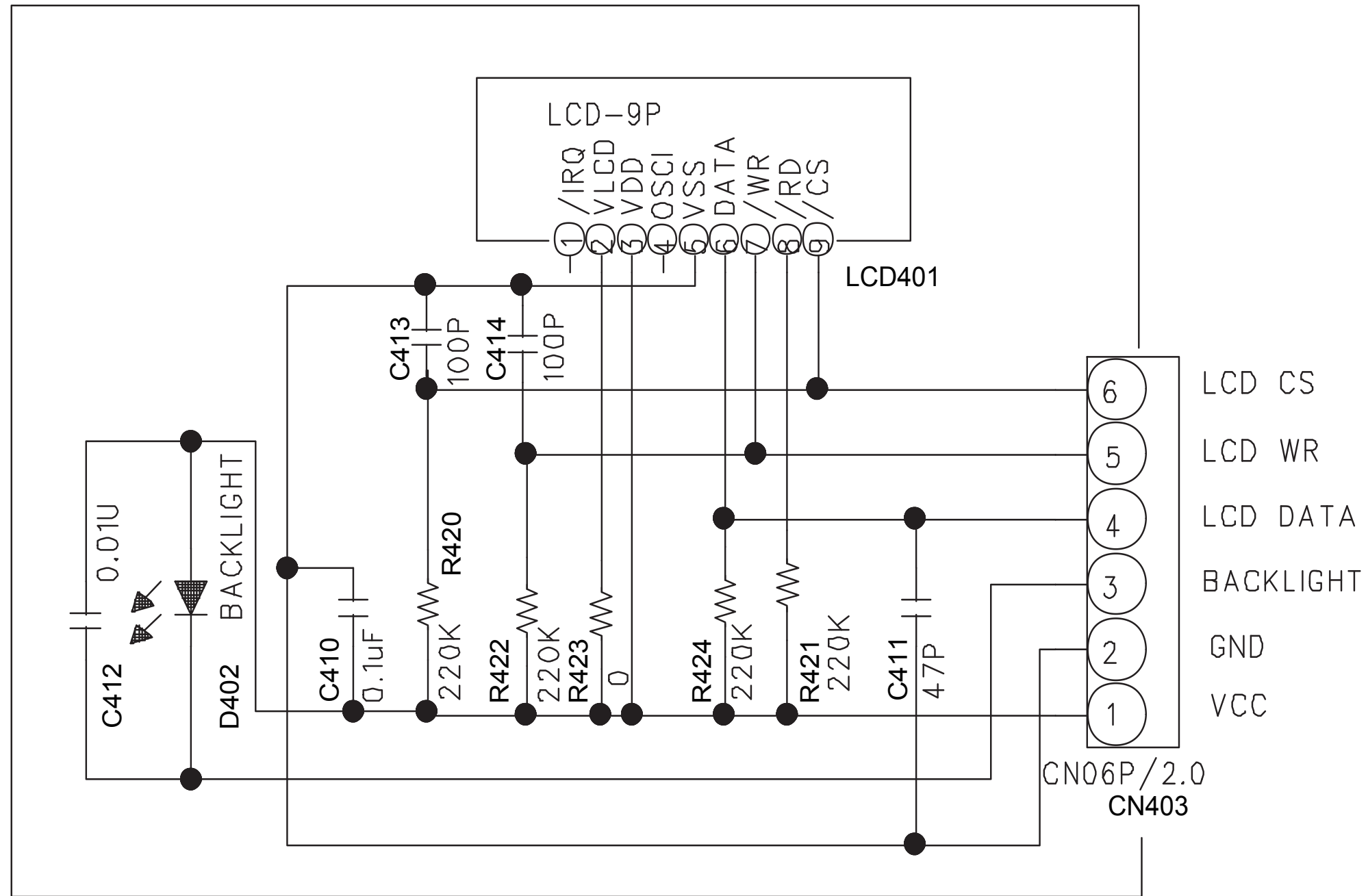
<Function section>



<USB Jack section>

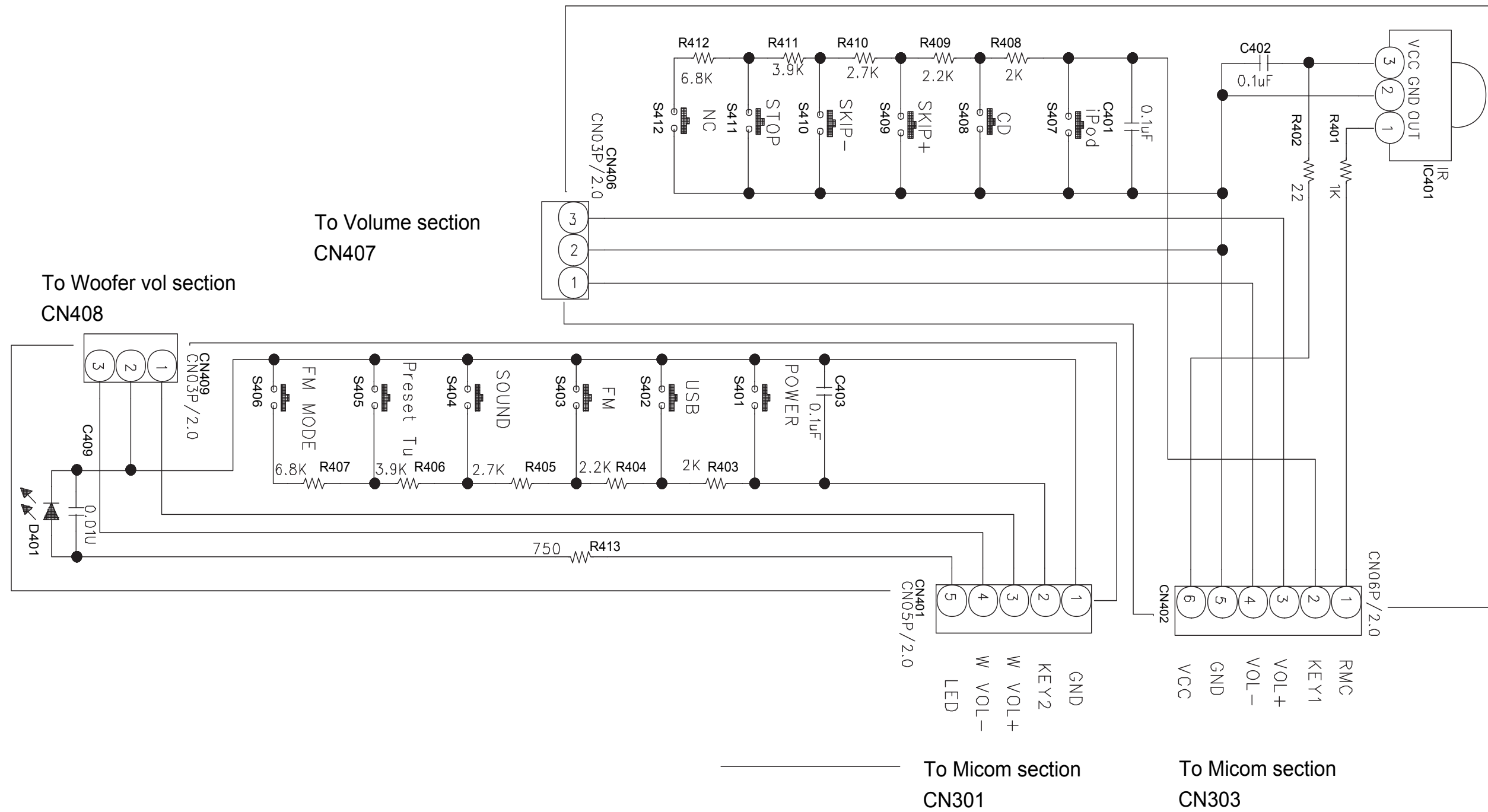


# <LCD section>

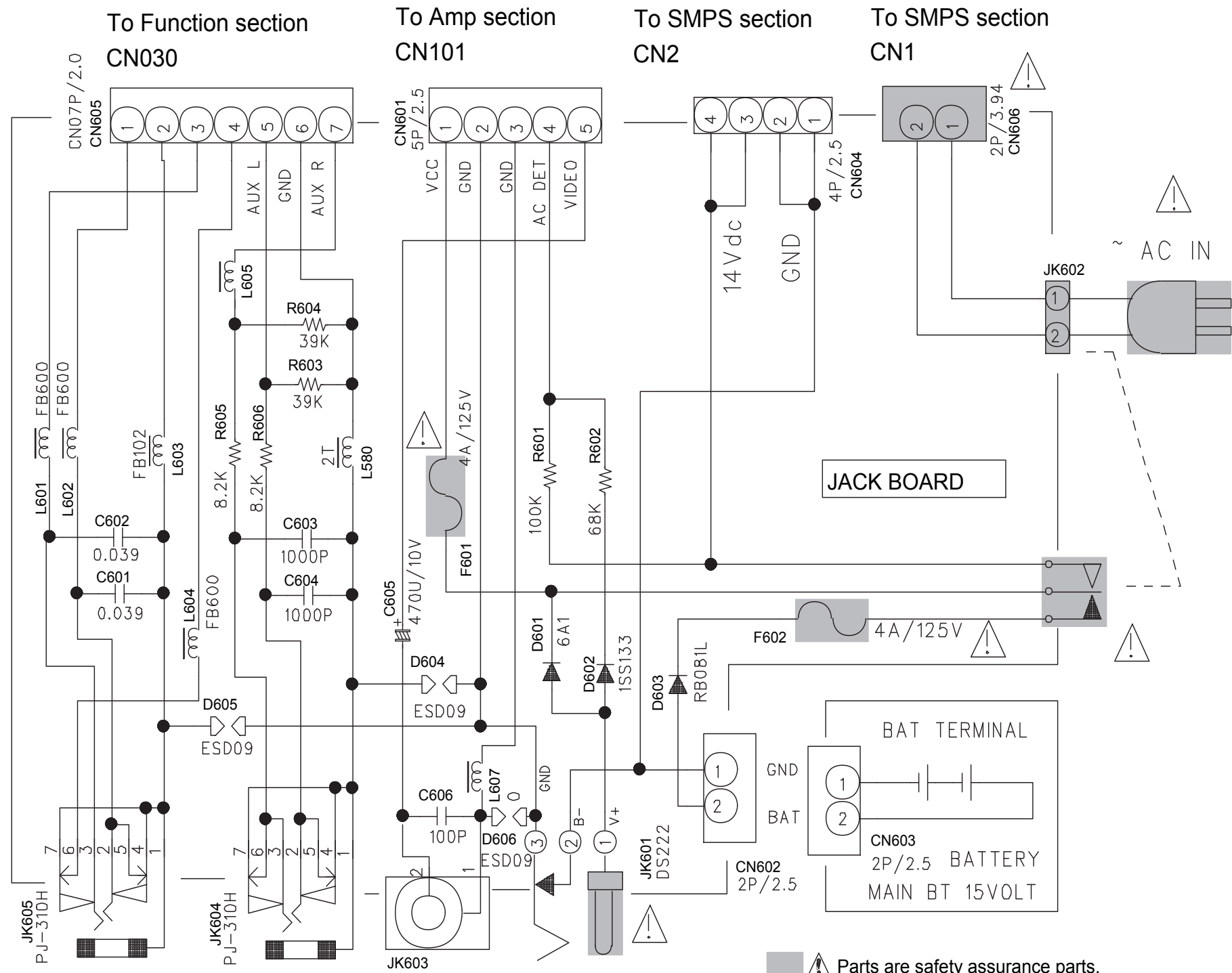


To Micom section  
CN304

<Key section>



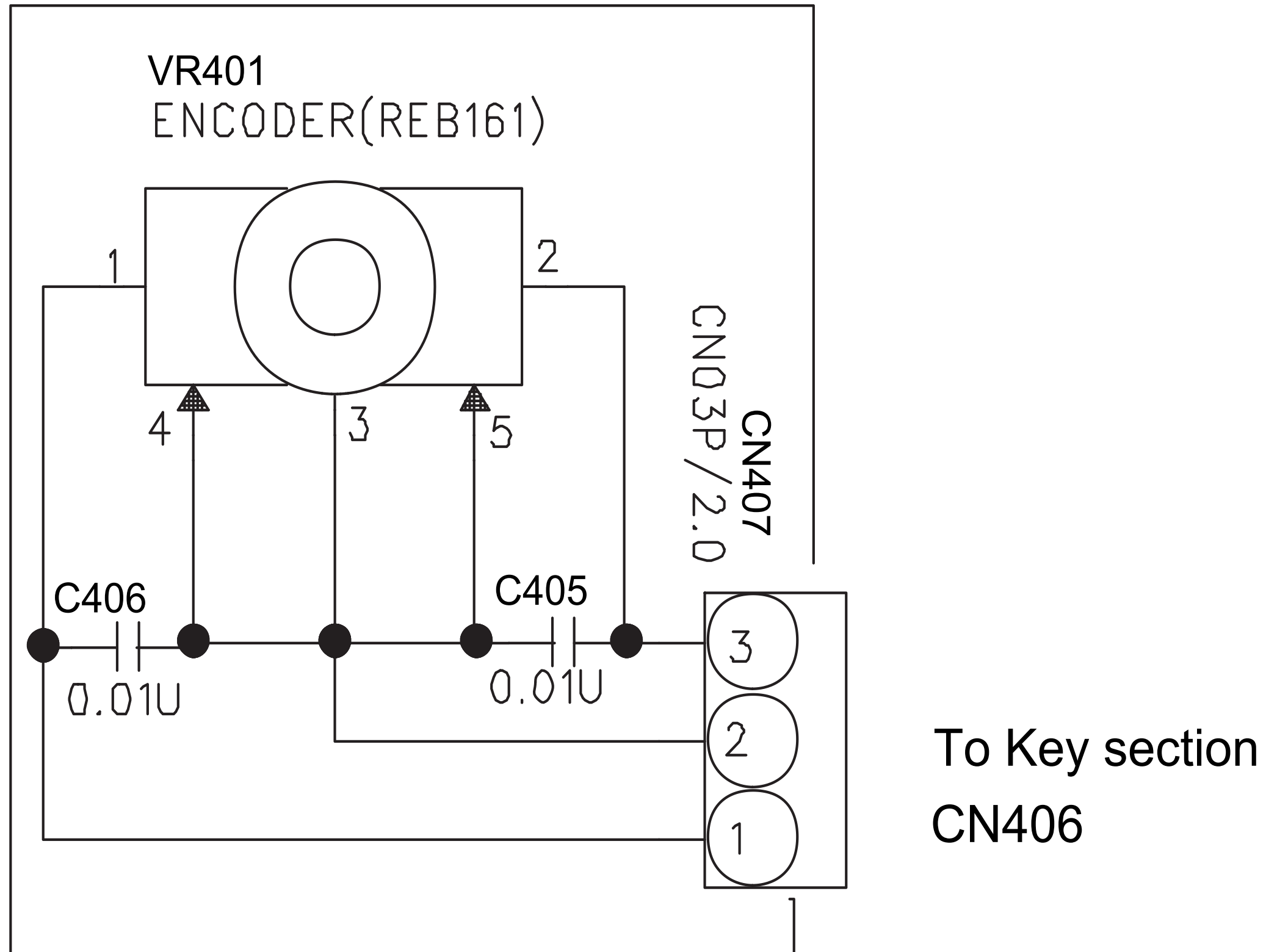
<Jack section>



⚠ Parts are safety assurance parts.  
When replacing those parts make  
sure to use the specified one.

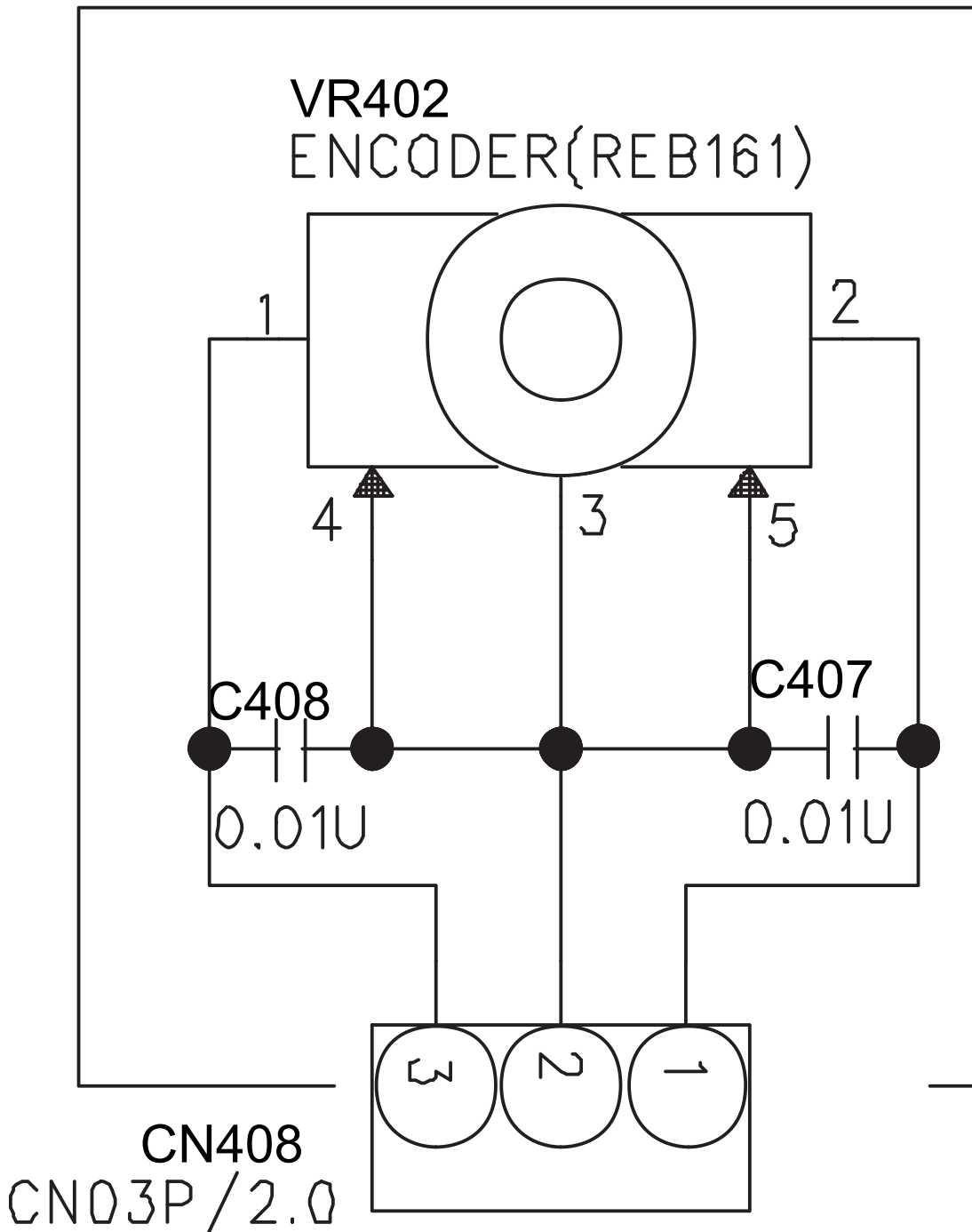
HP out Audio in Video out DC 12V

# <Volume section>



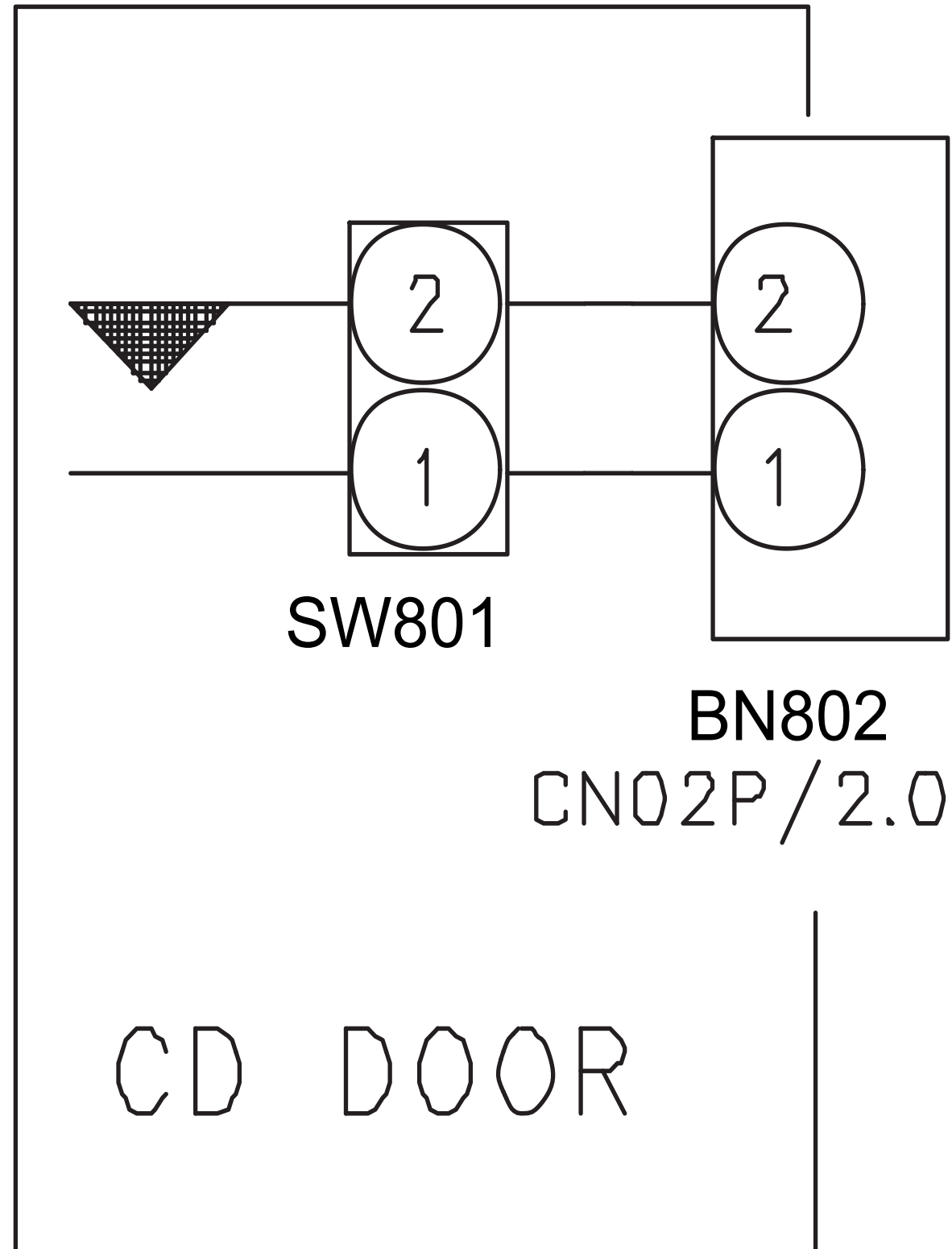


# <Woofers vol section>



To Key section  
CN409

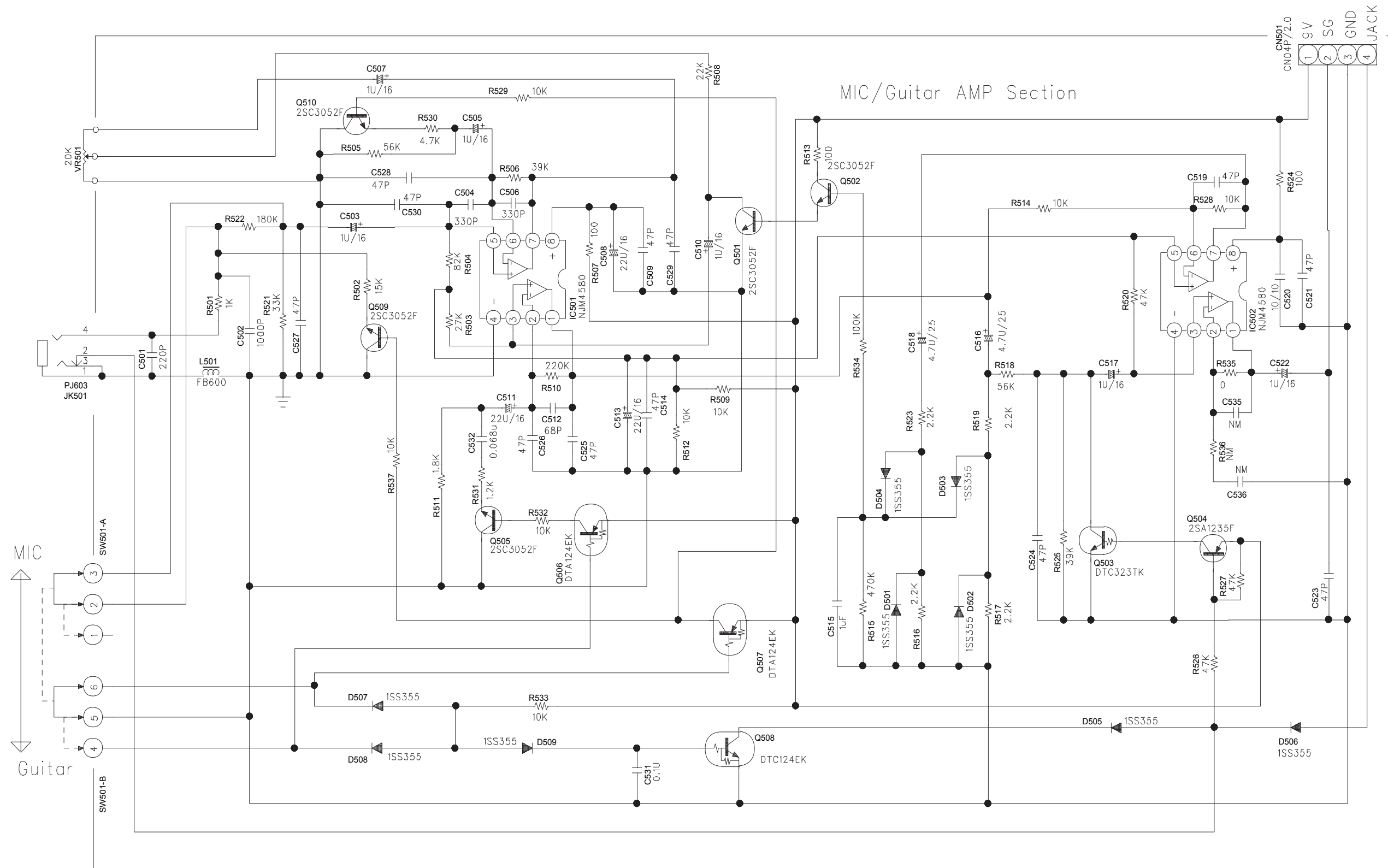
<Door switch section>



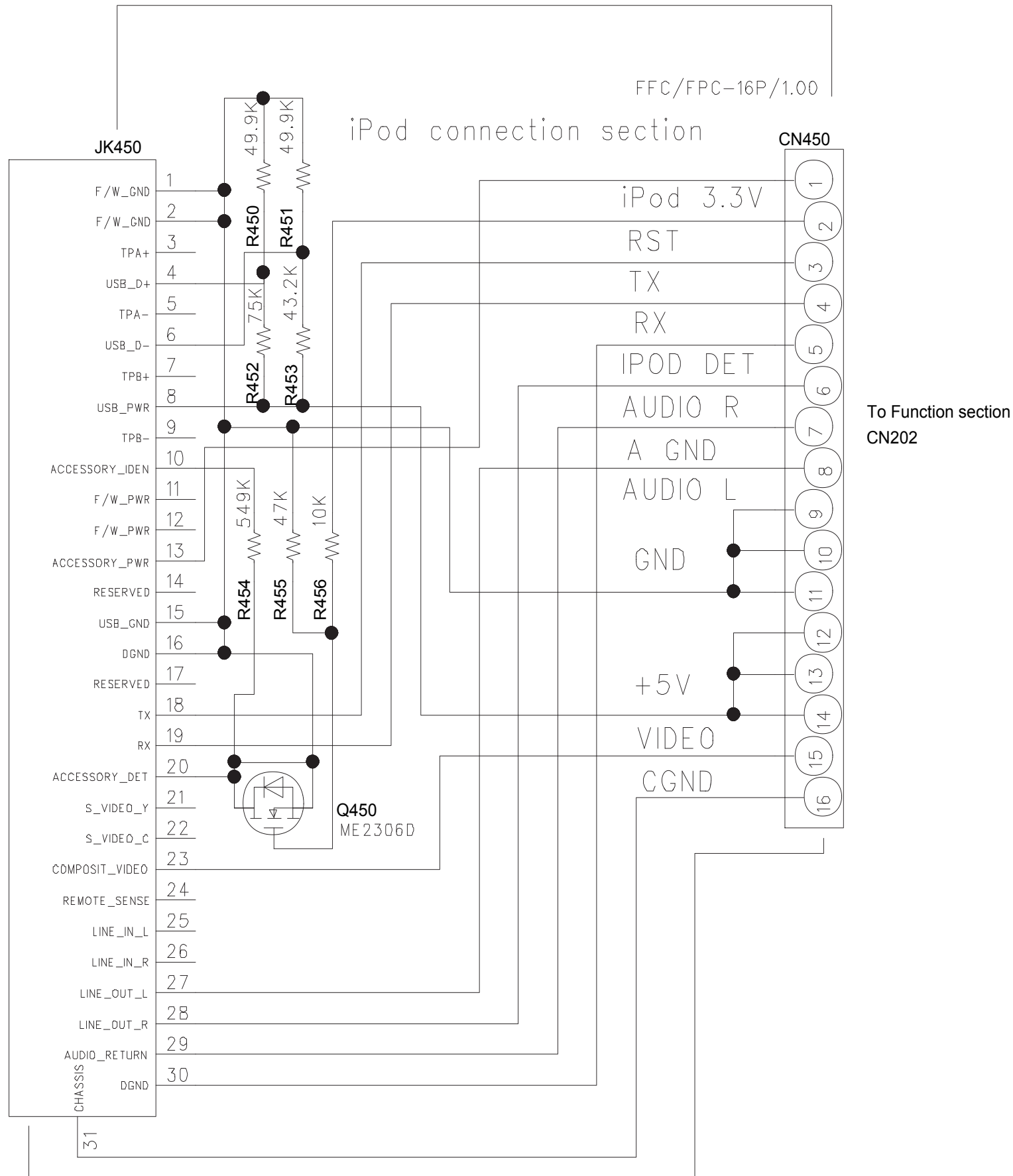
To Micom section  
CN305

<Mic section>

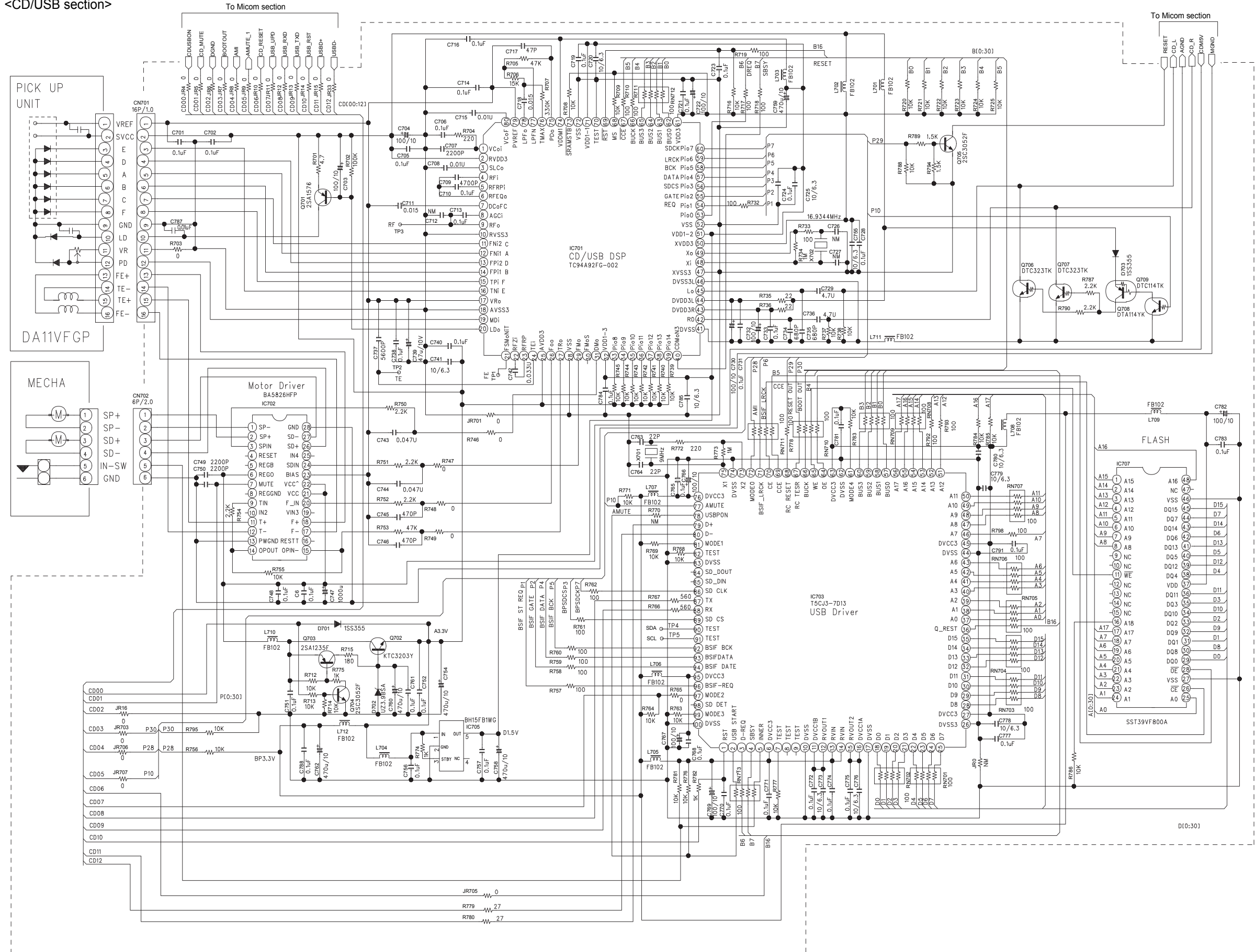
To Function section  
CN060



<iPod section>



<CD/USB section>

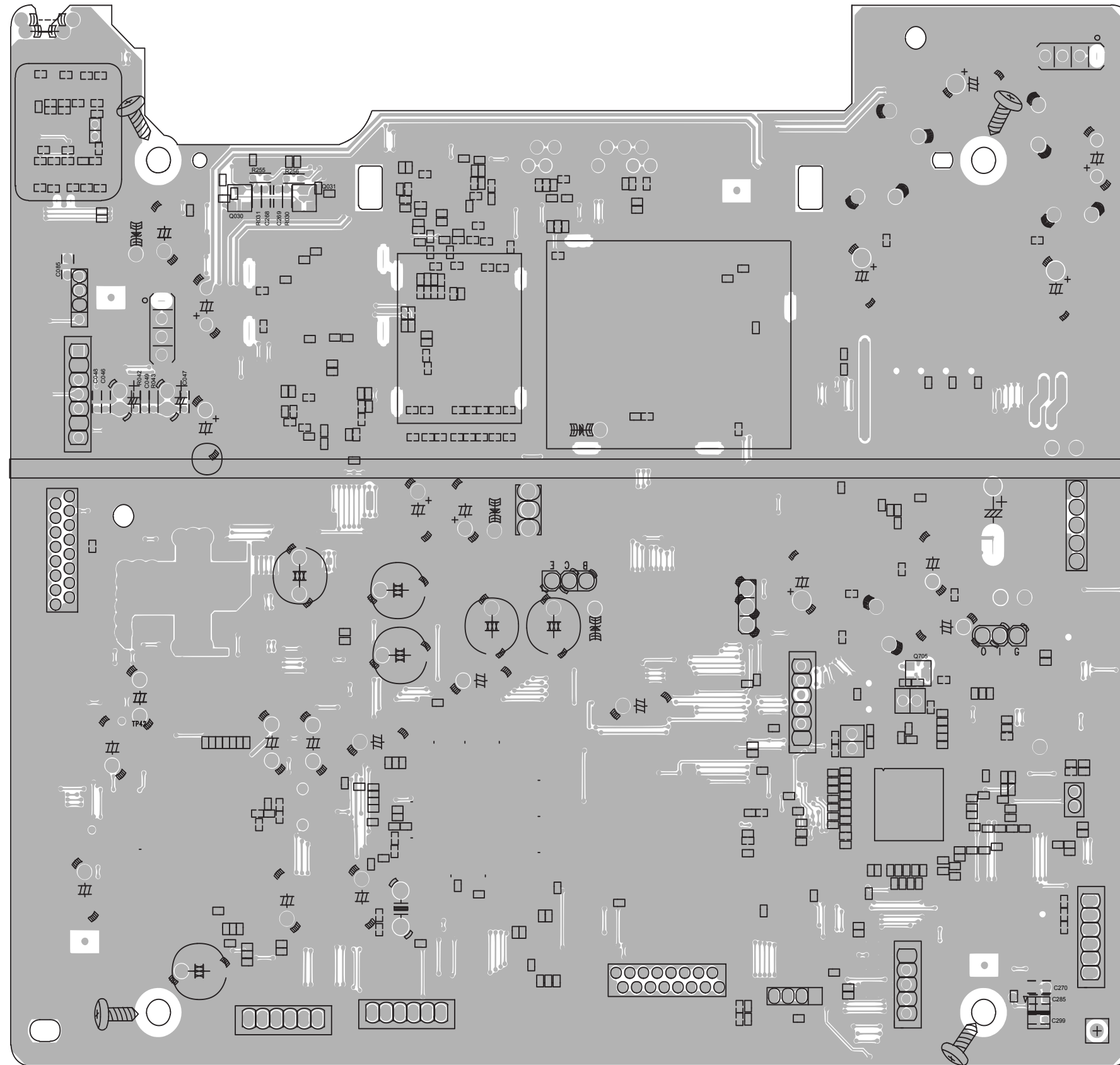






<Main board (reverse side)>

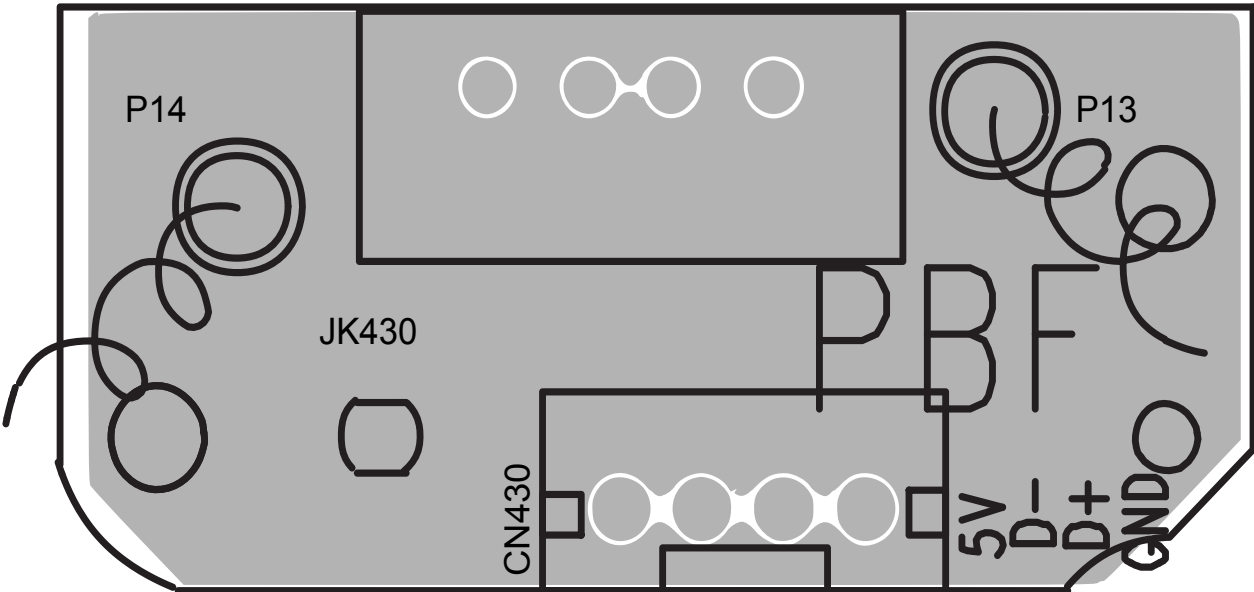
(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))



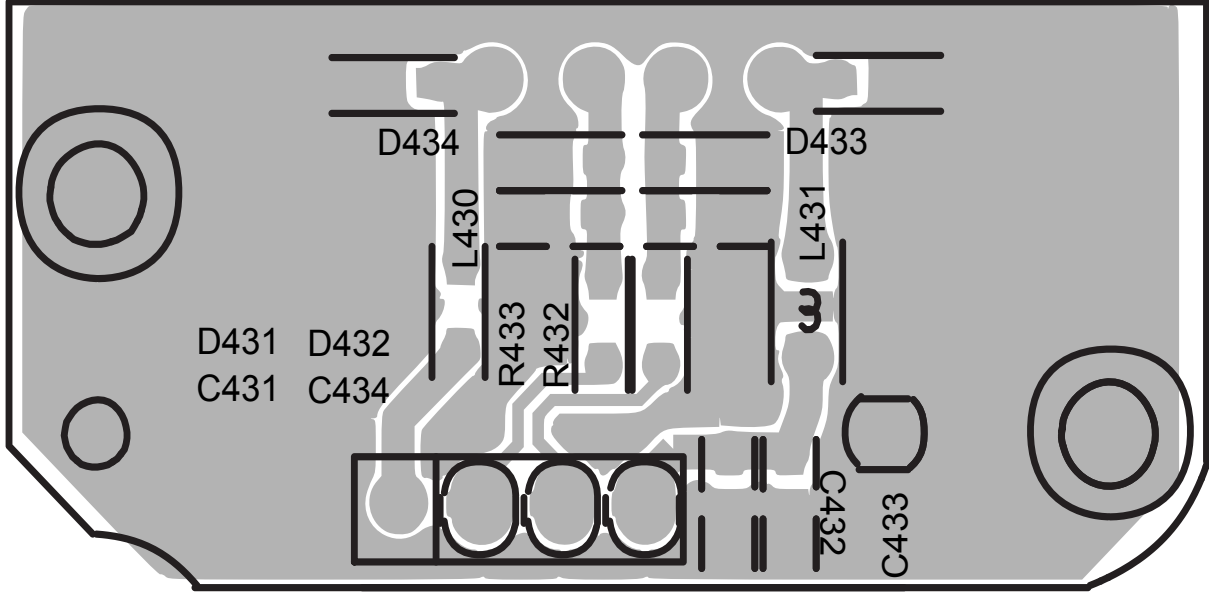
<USB board>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(foward side)



(reverse side)

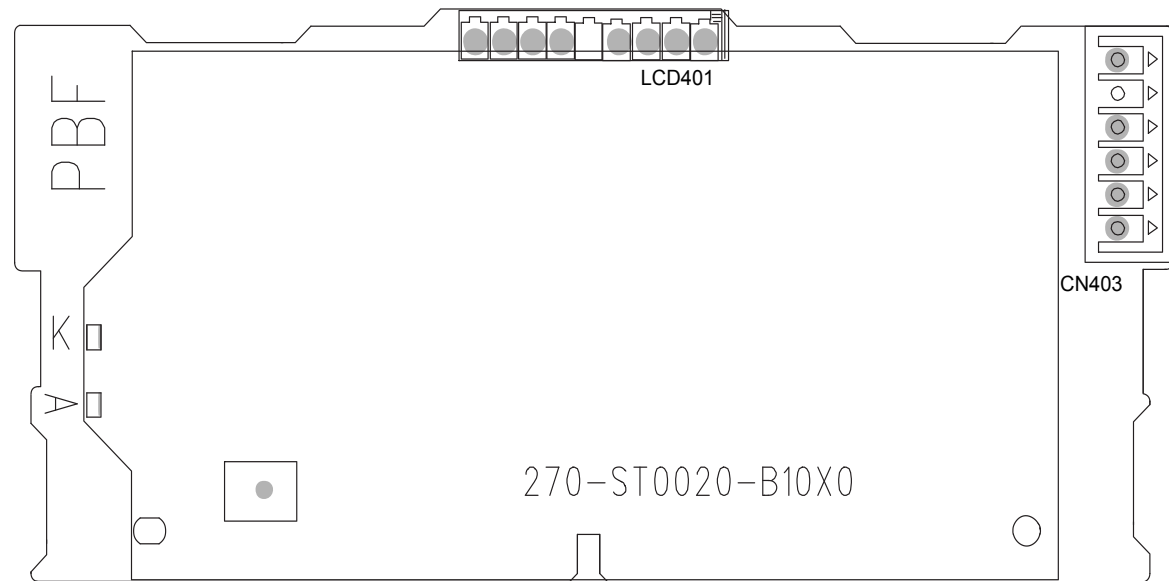




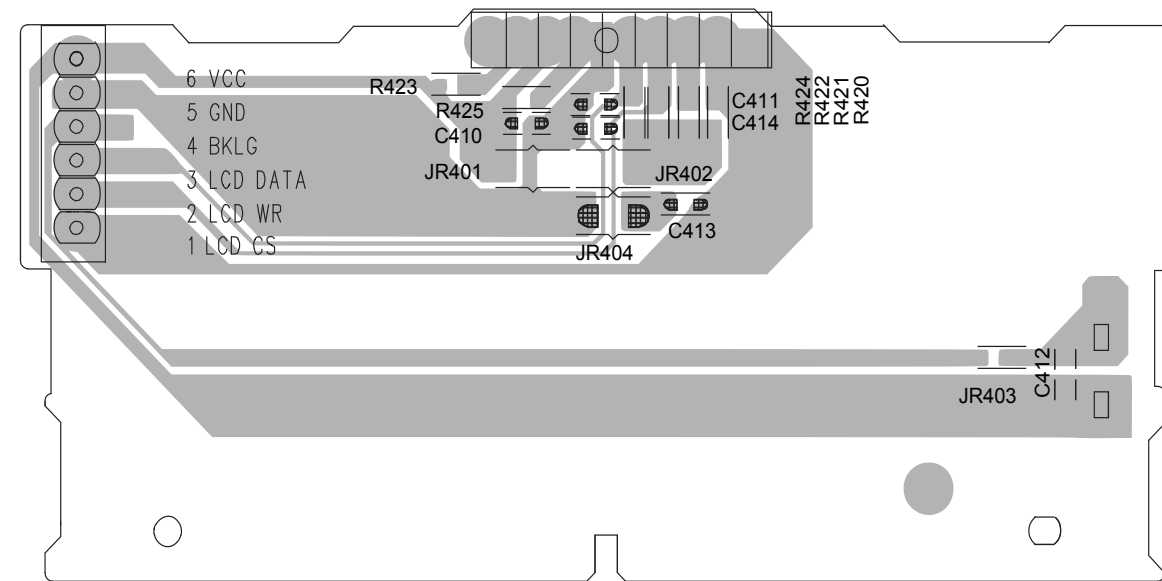
# <LCD board>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(forward side)



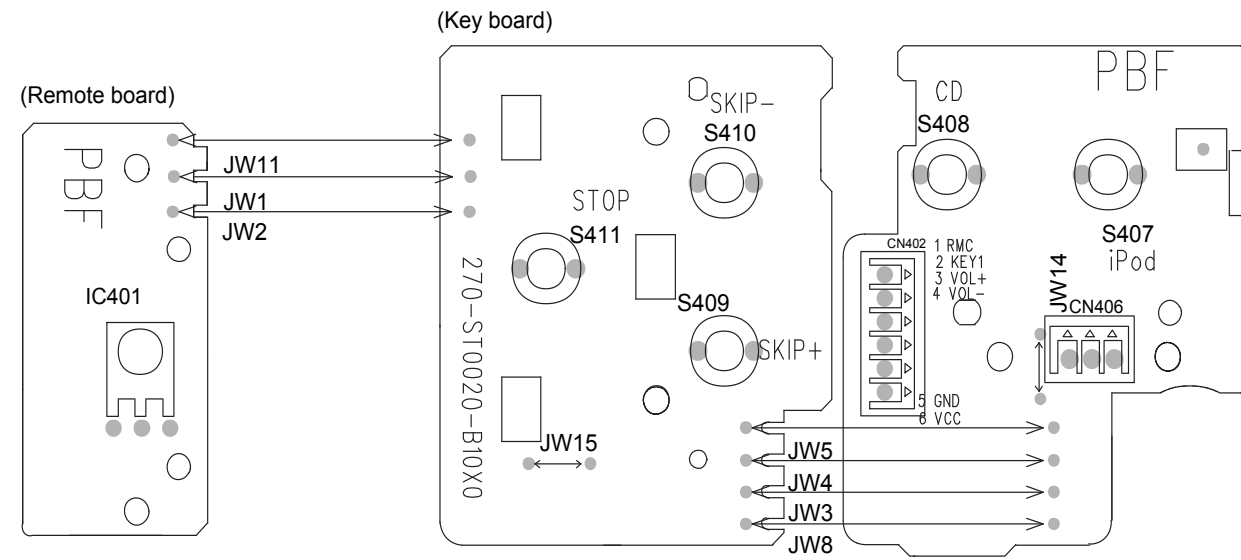
(reverse side)



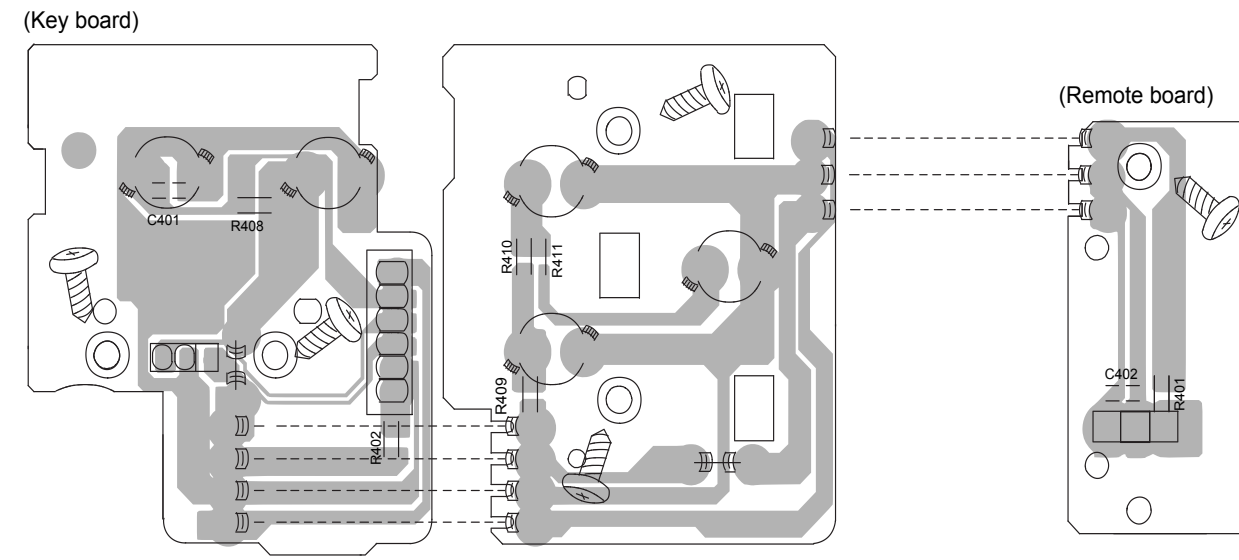
# <Key board 1>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(forward side)



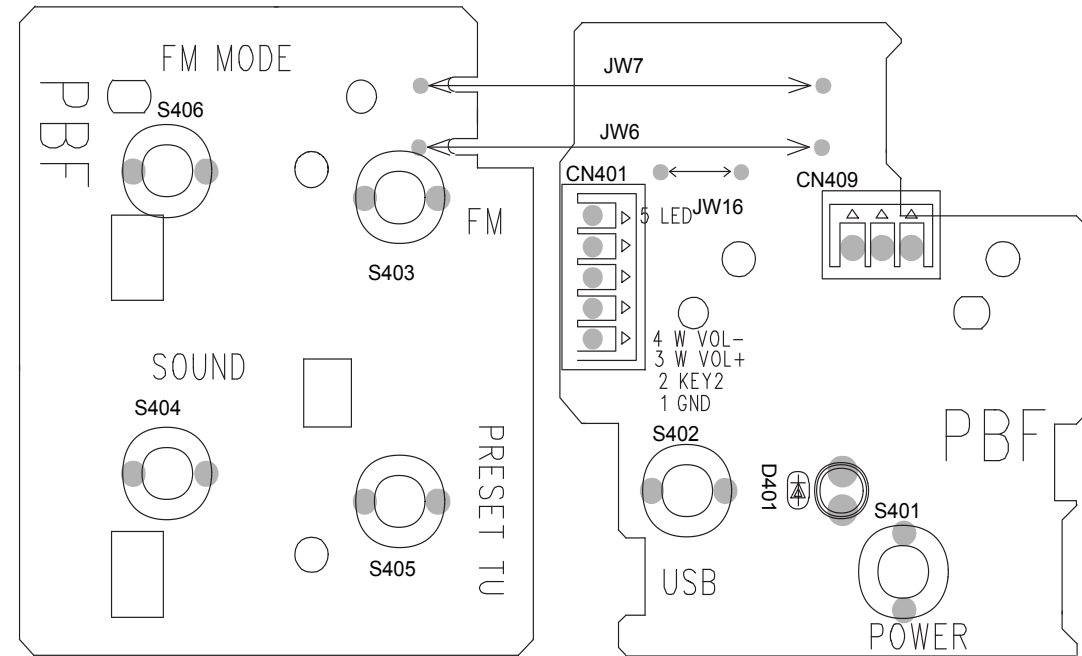
(reverse side)



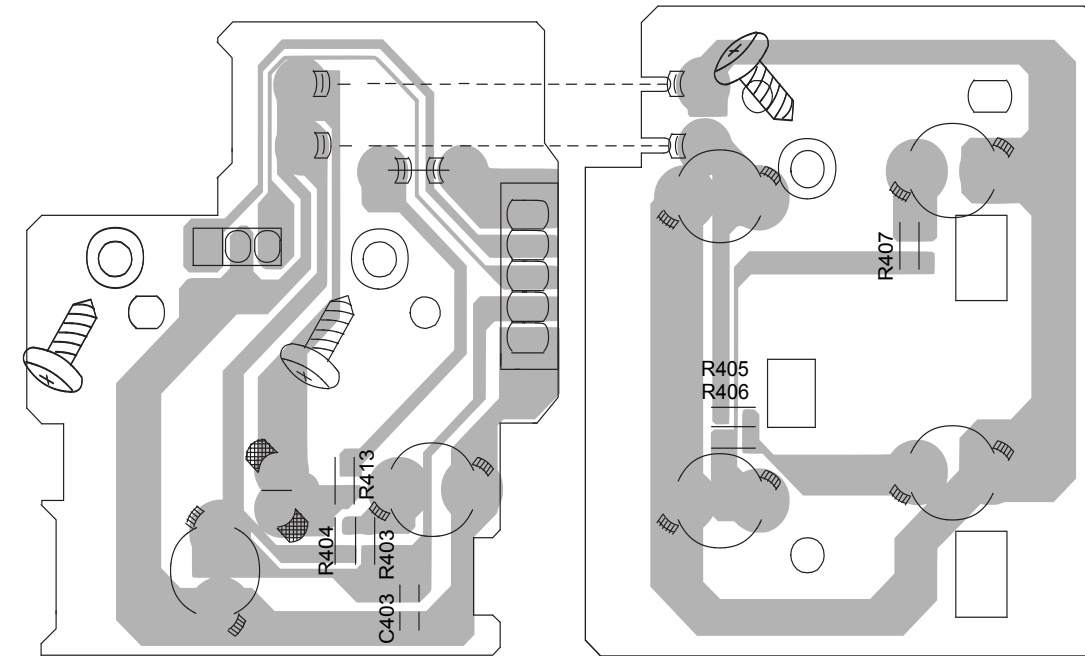
# <Key board 2>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(forward side)



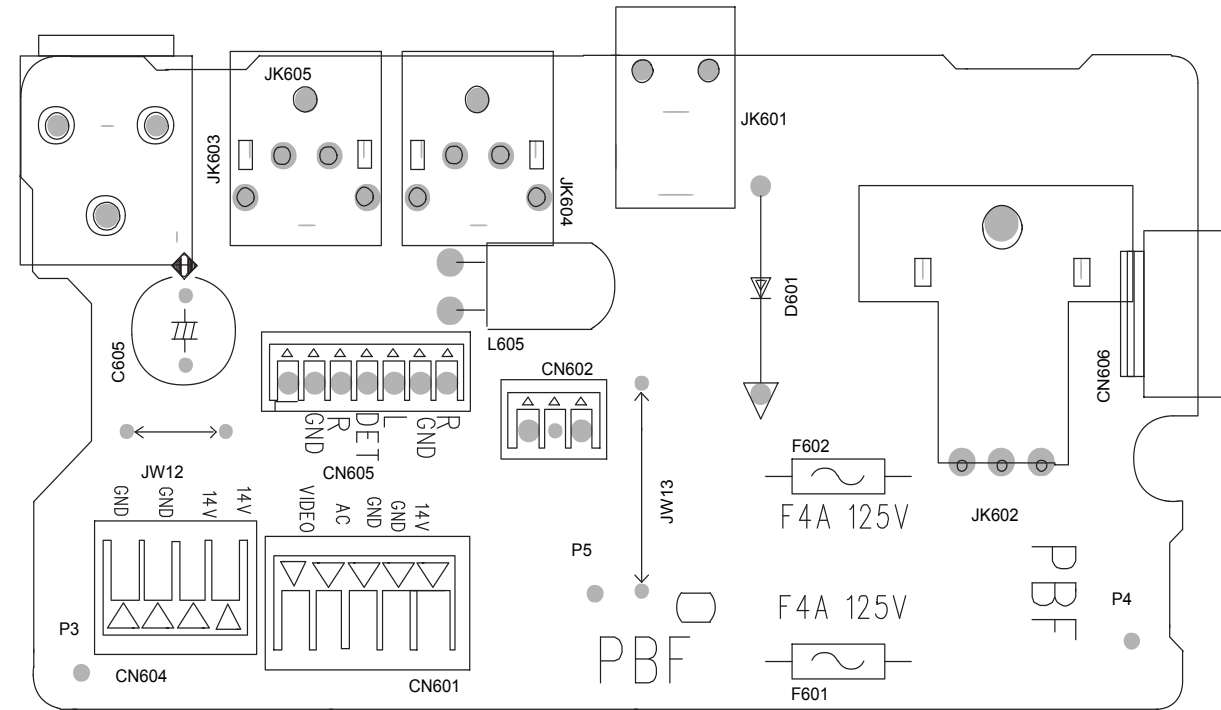
(reverse side)



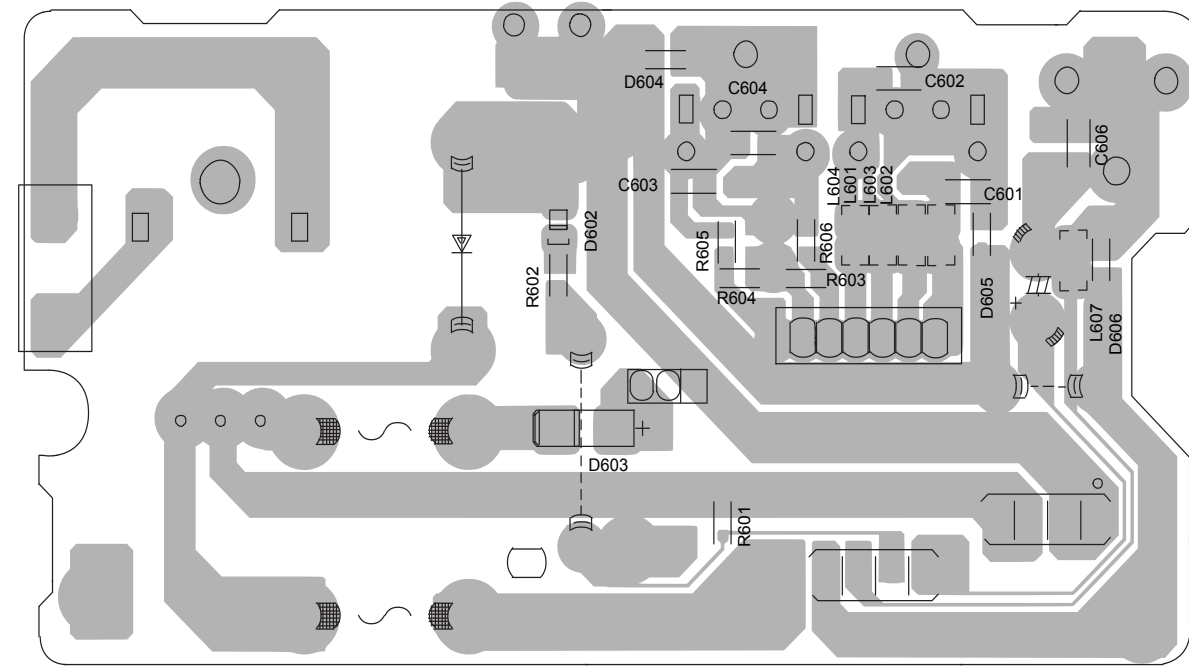
# <Jack board>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(forward side)



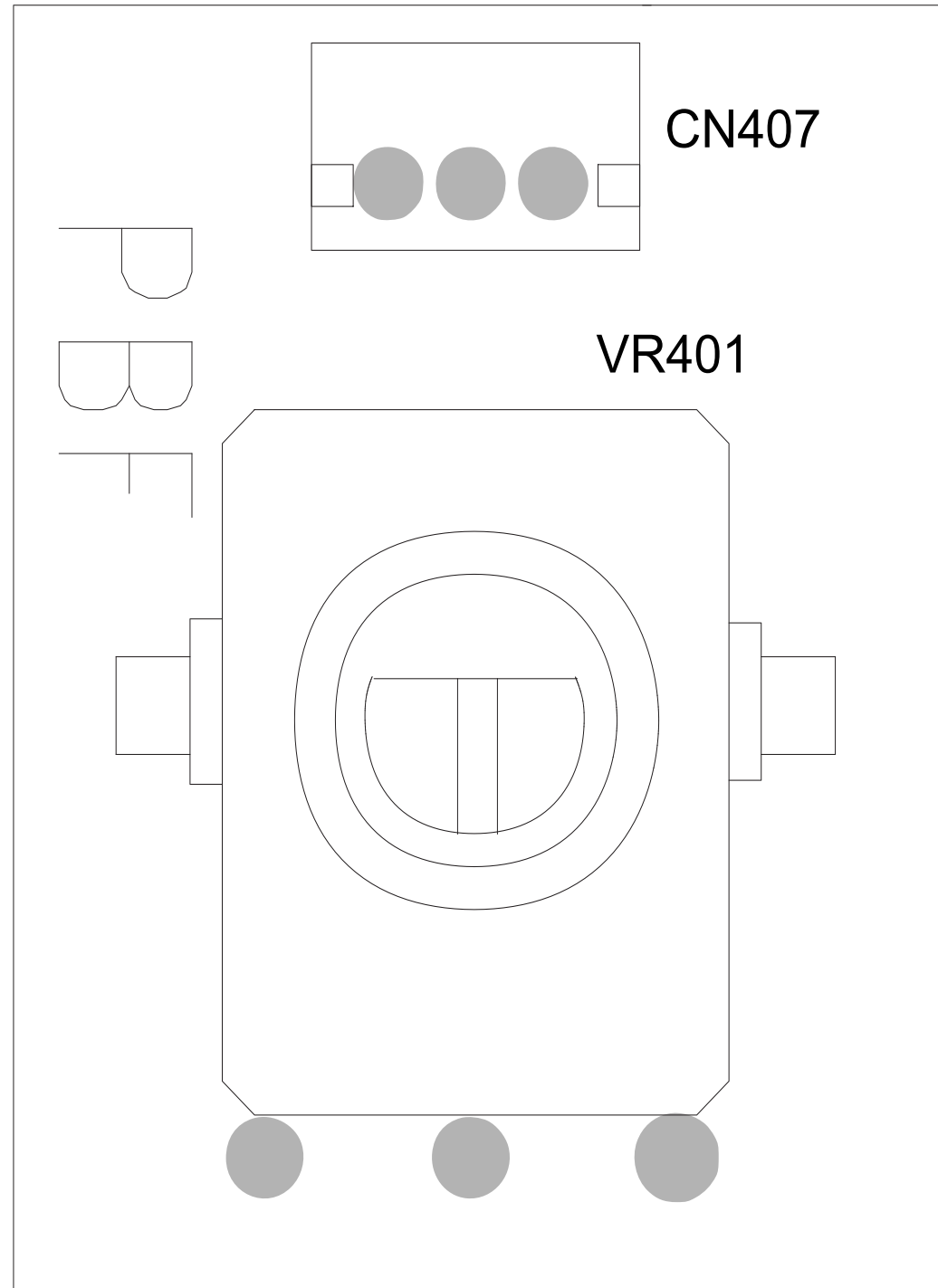
(reverse side)



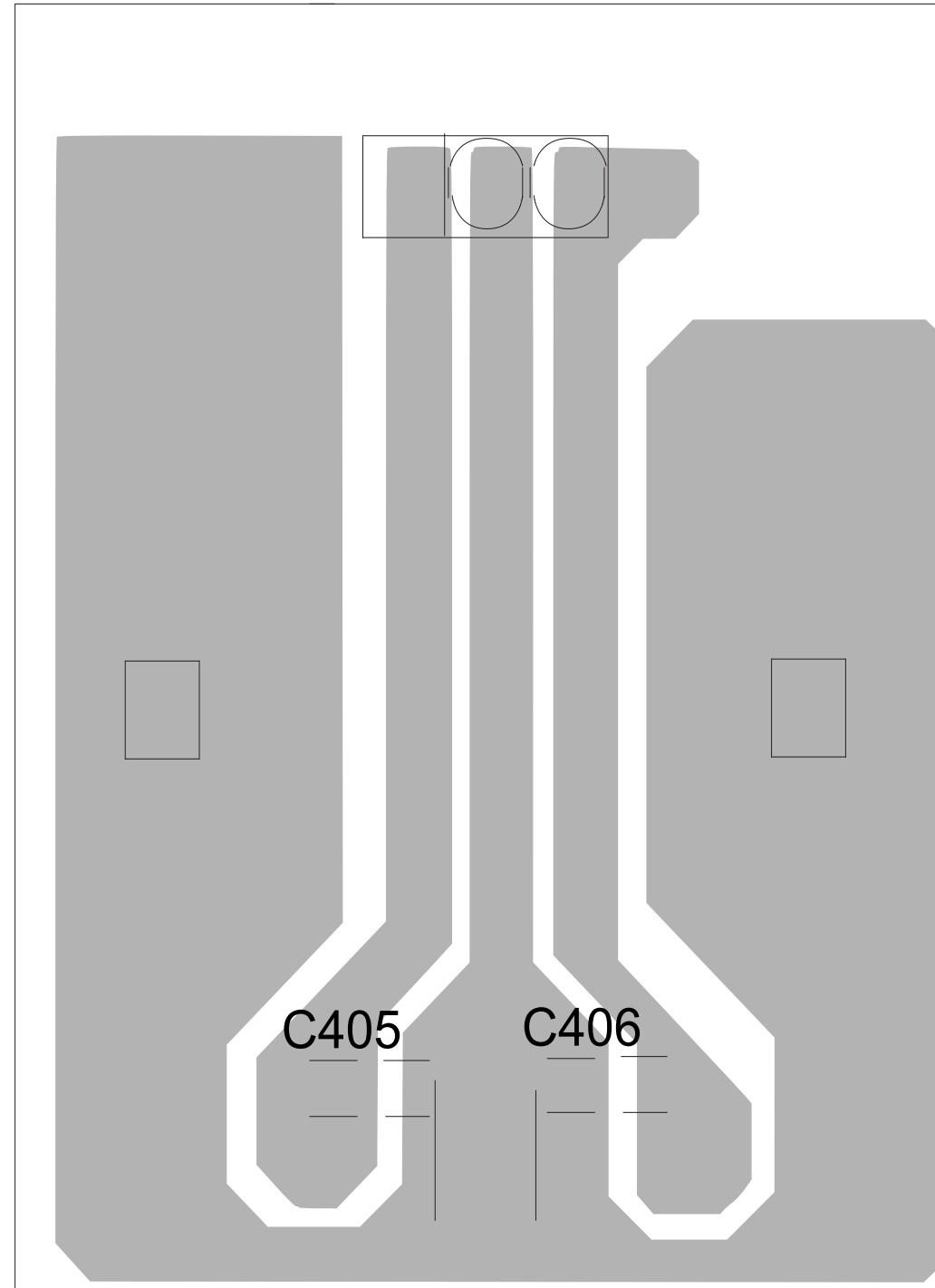
# <Volume board>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(forward side)



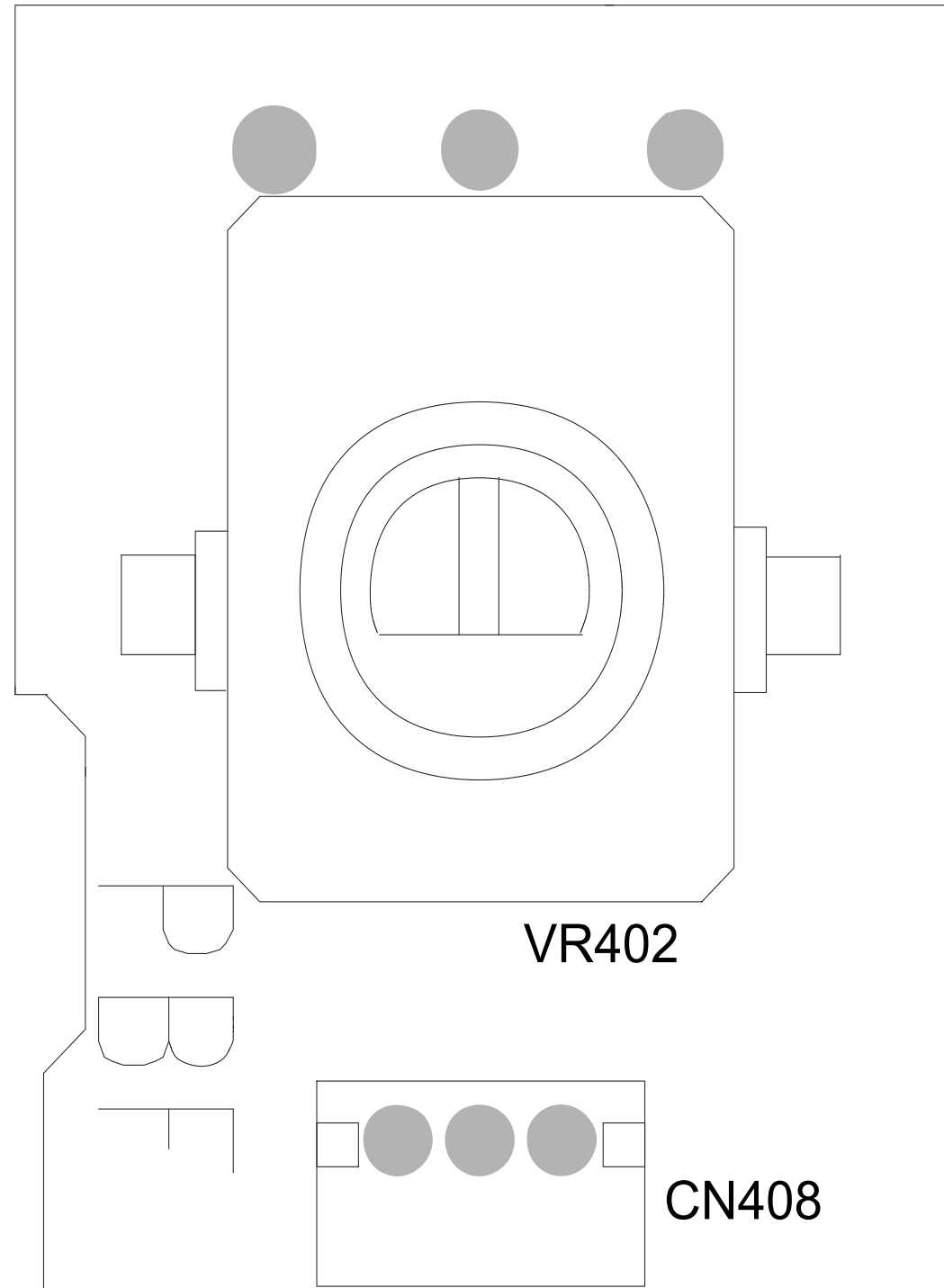
(reverse side)



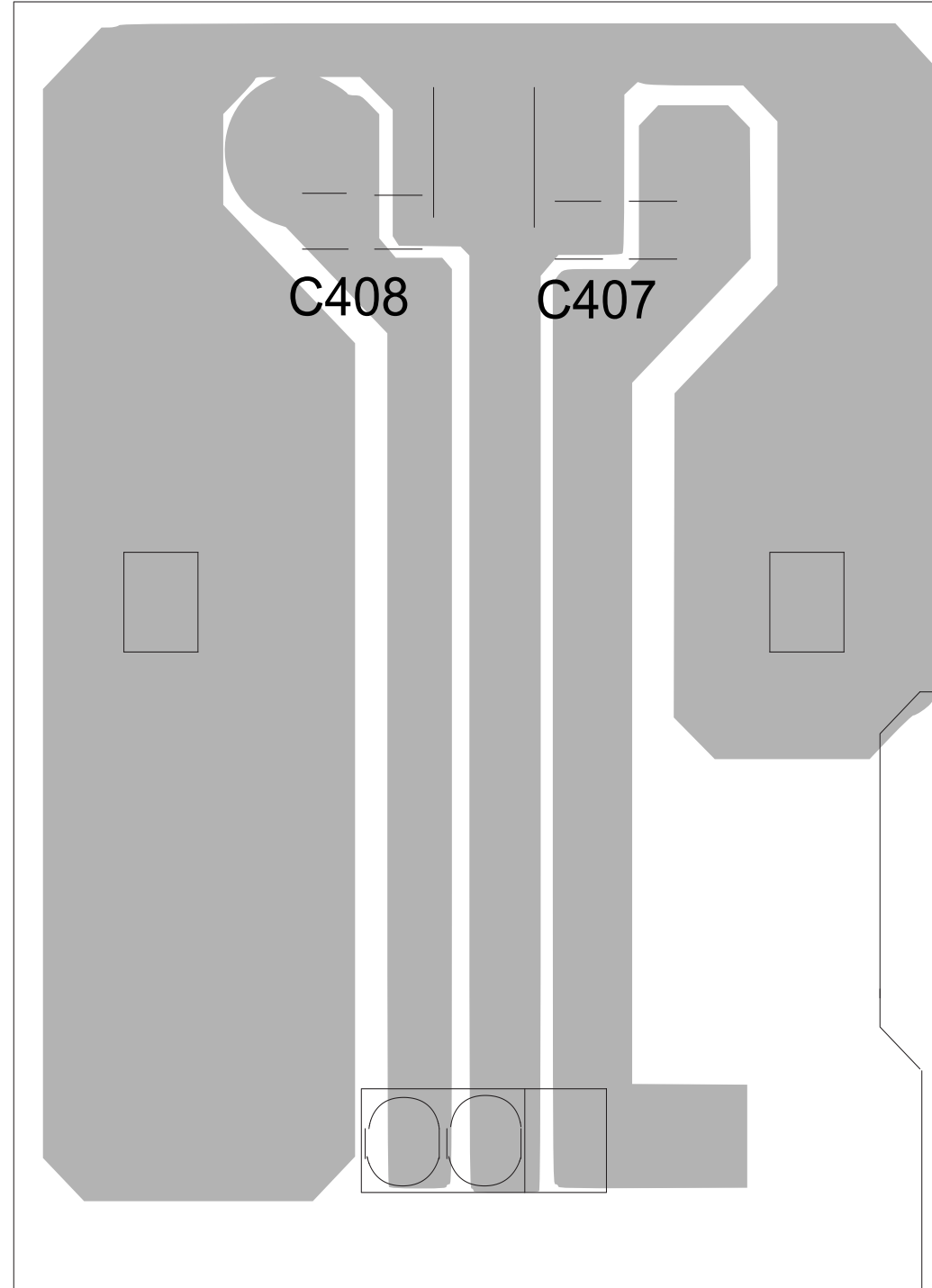
# <Woofler vol board>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(foward side)



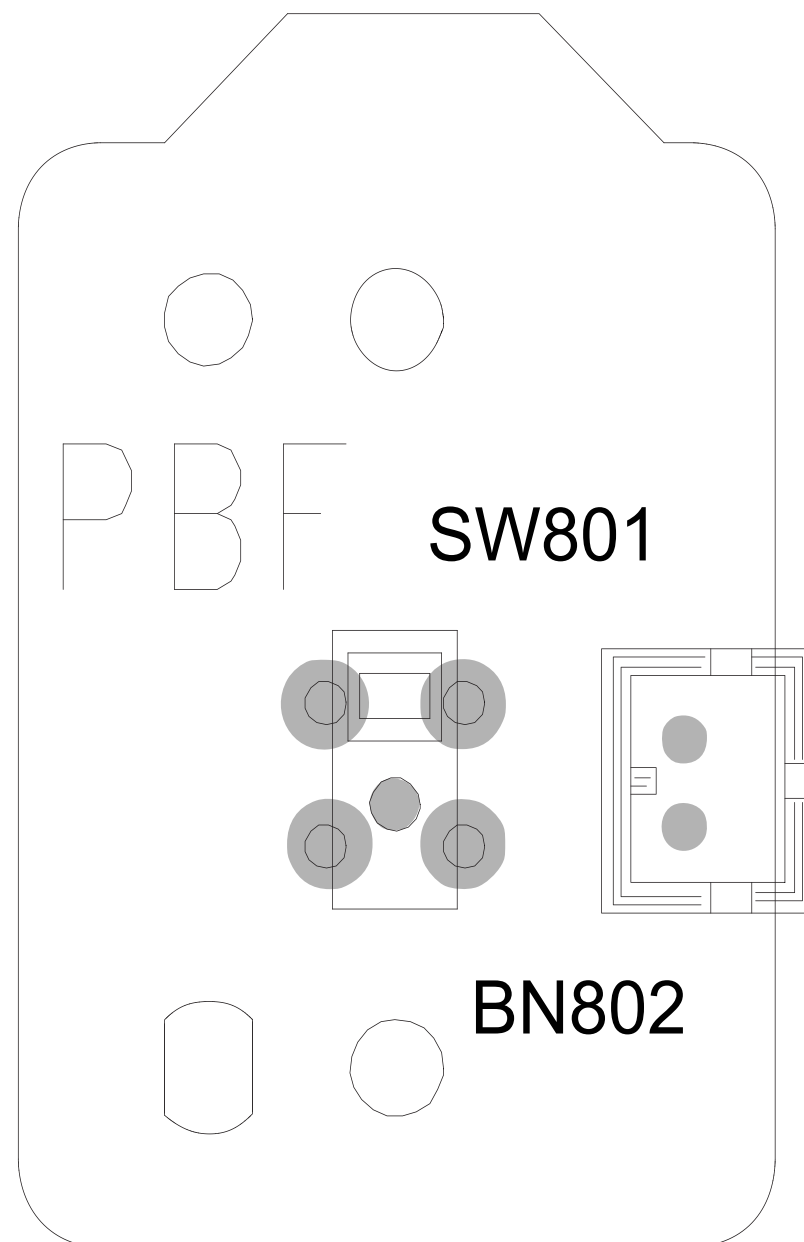
(reverse side)



# <Door switch board>

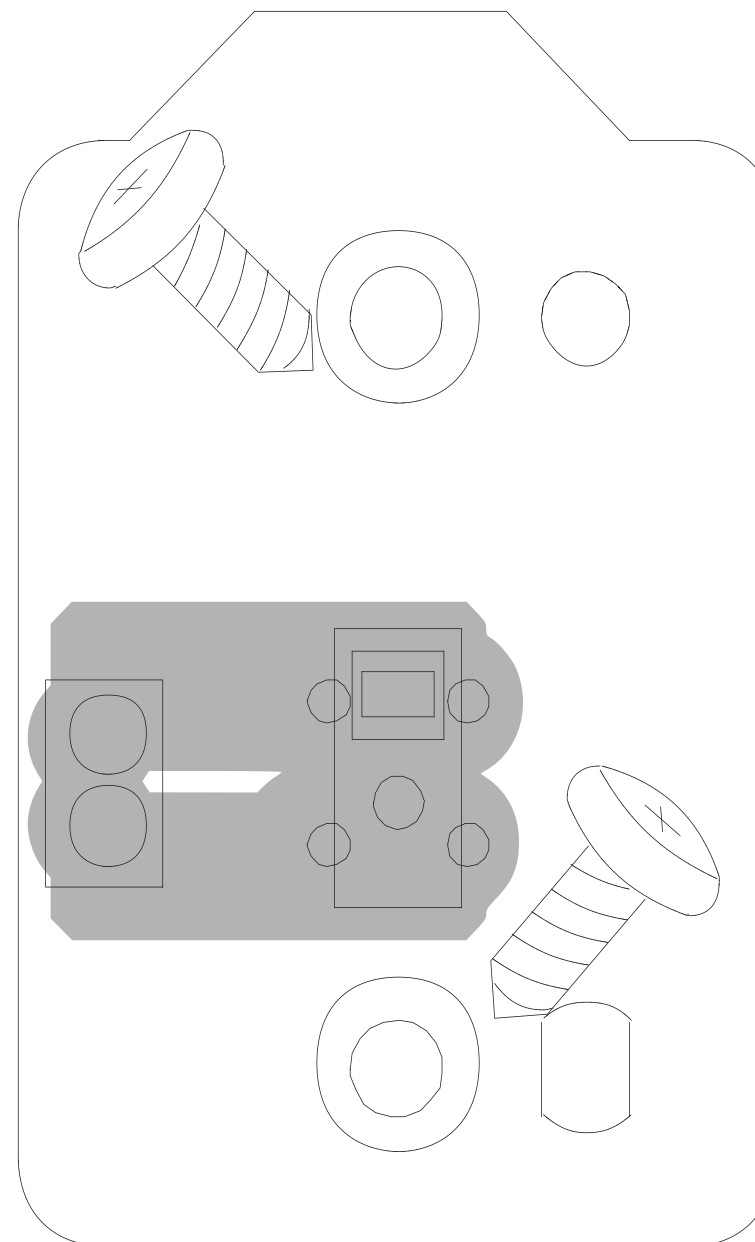
(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(foward side)



No.MB749

(reverse side)



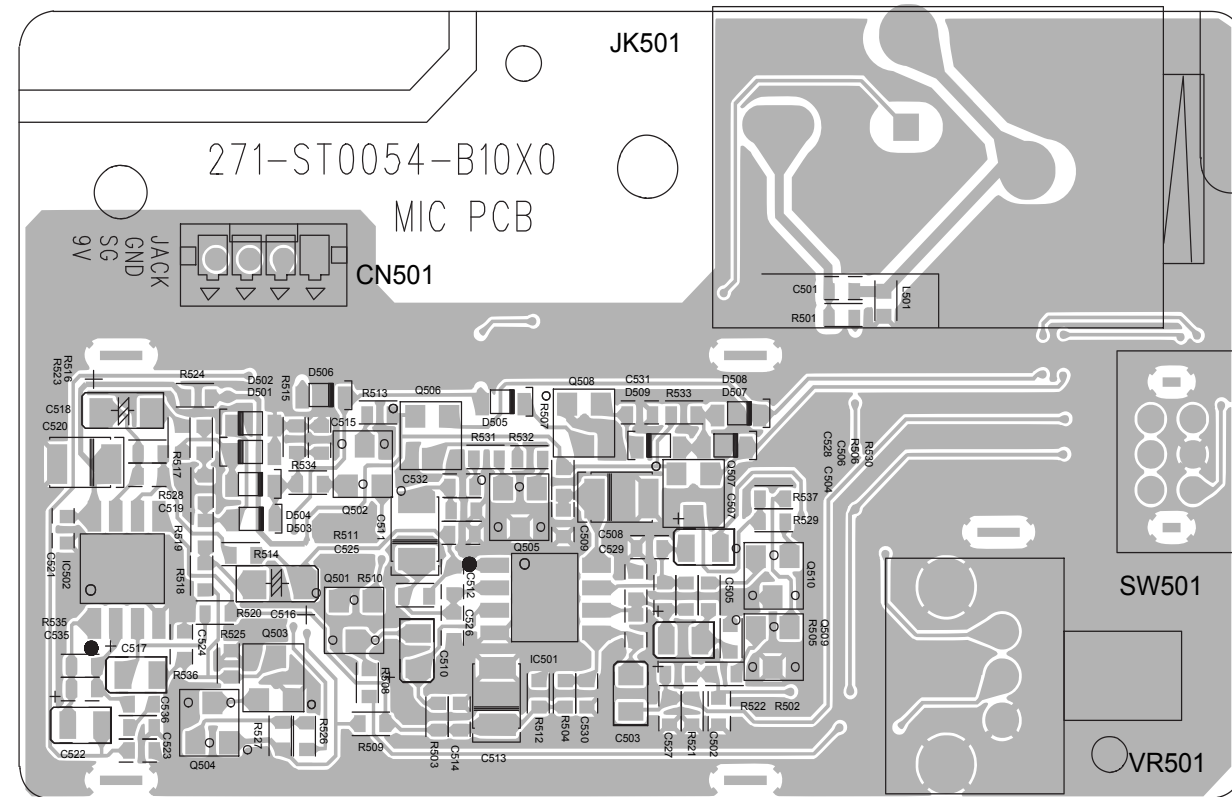
(No.MB749<Rev.002>)27/31

created date:2011-04-18

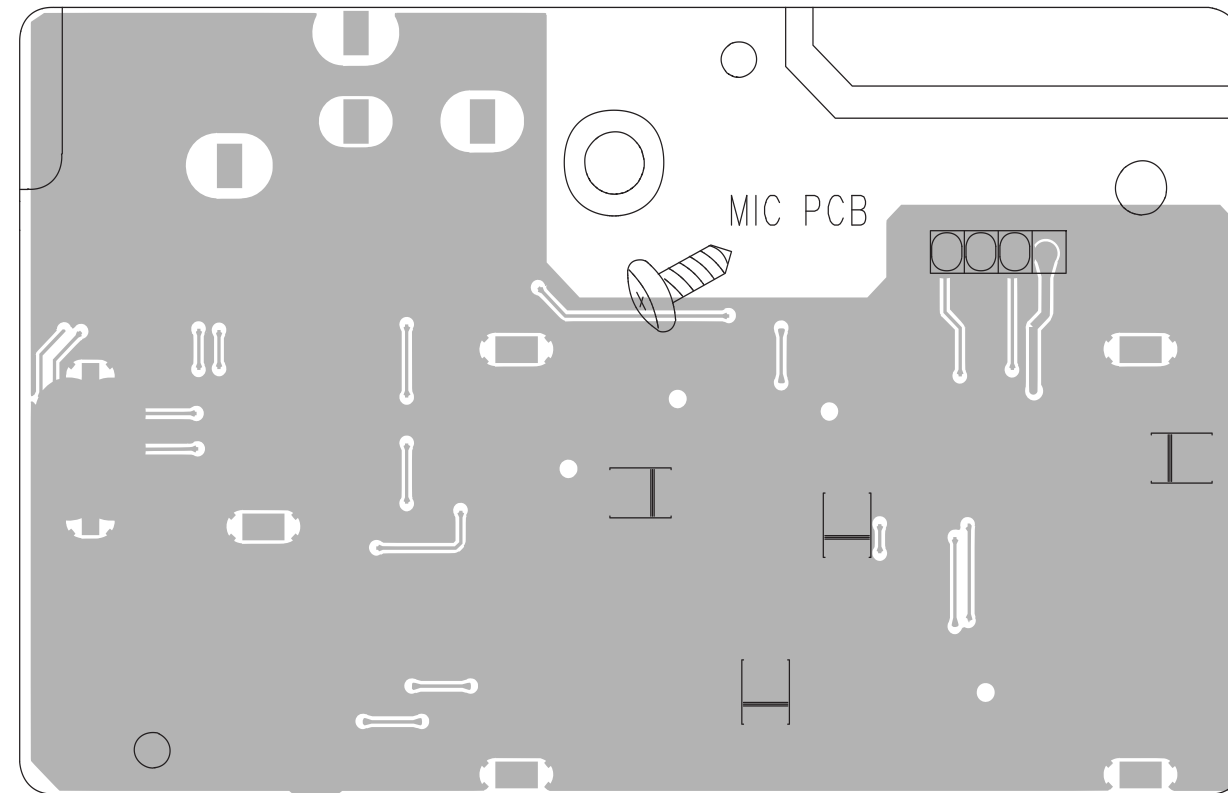
<Mic board>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(forward side)



(reverse side)

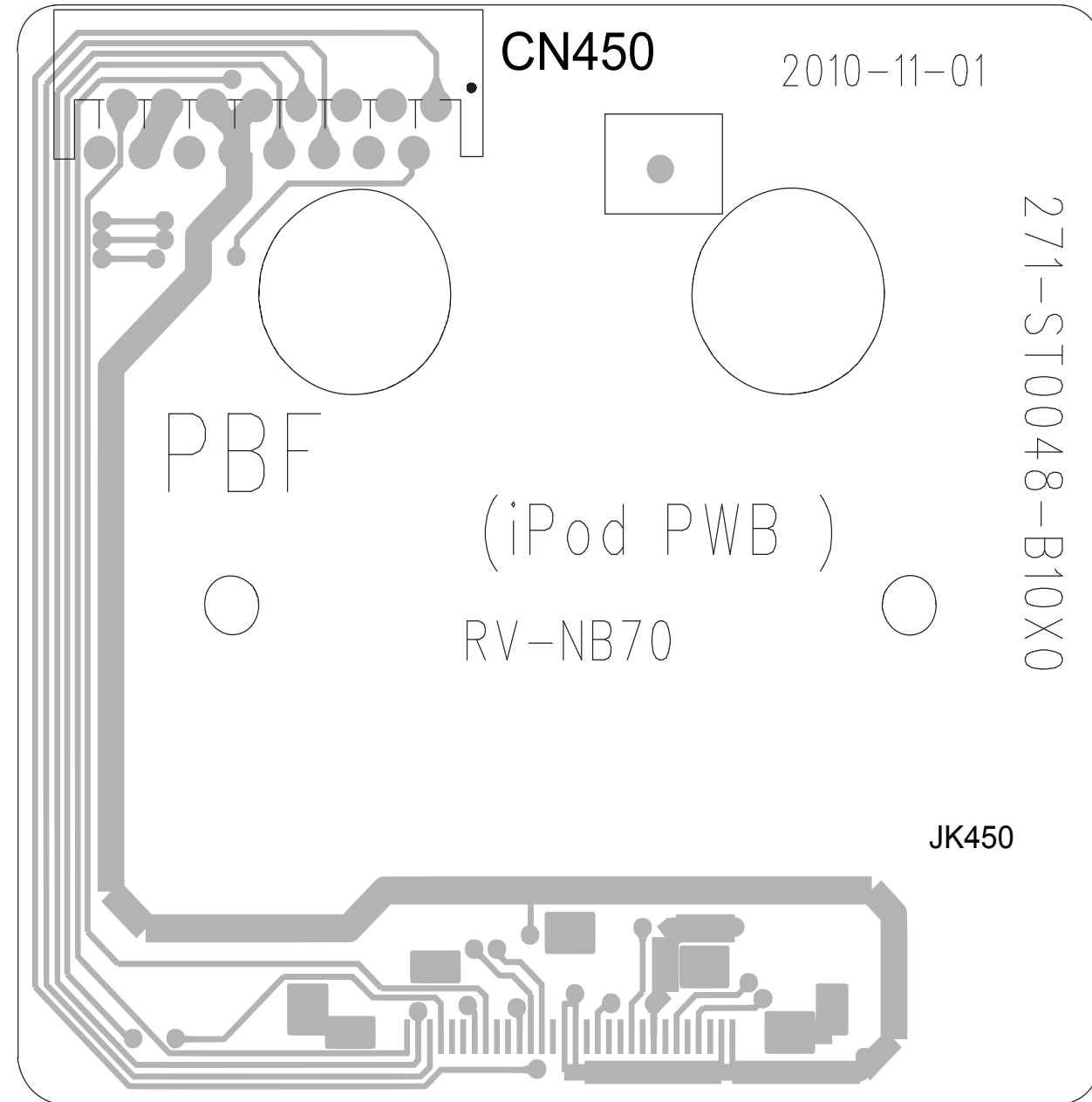




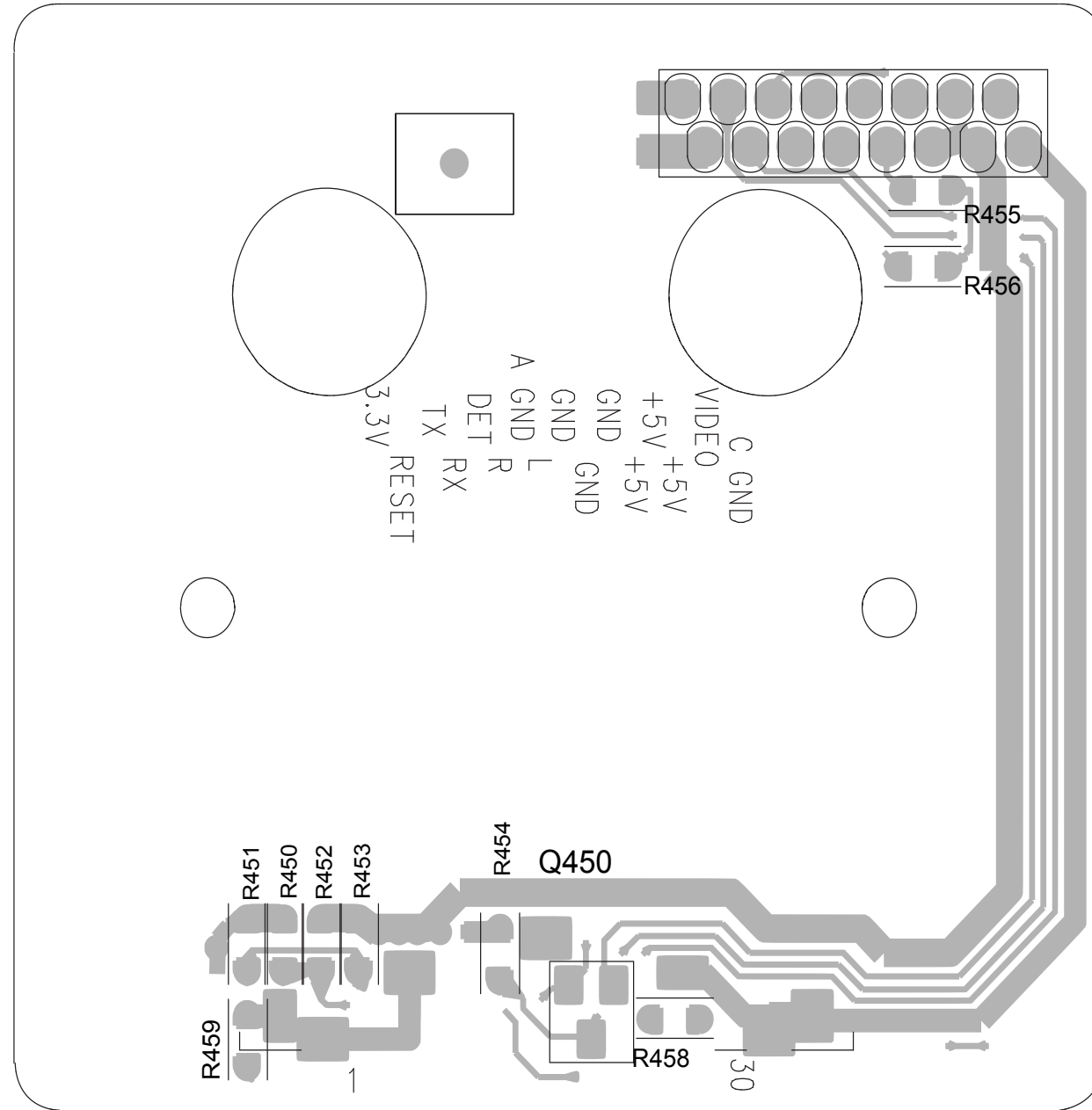
<iPod board>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(forward side)



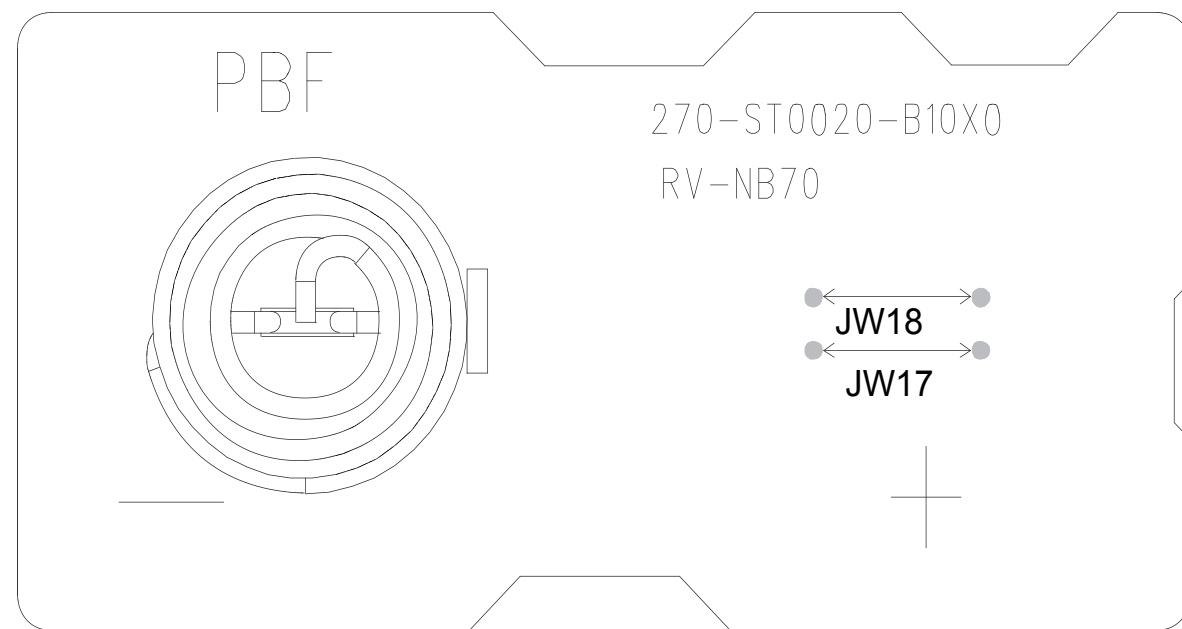
(reverse side)



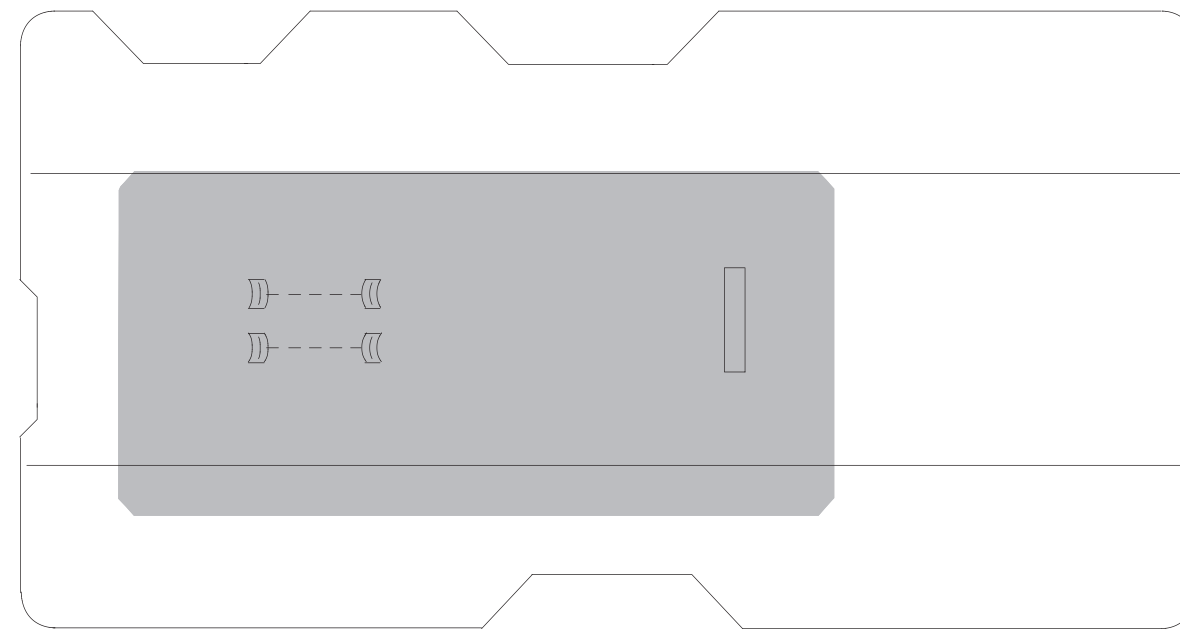
# <Battery board L>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(forward side)



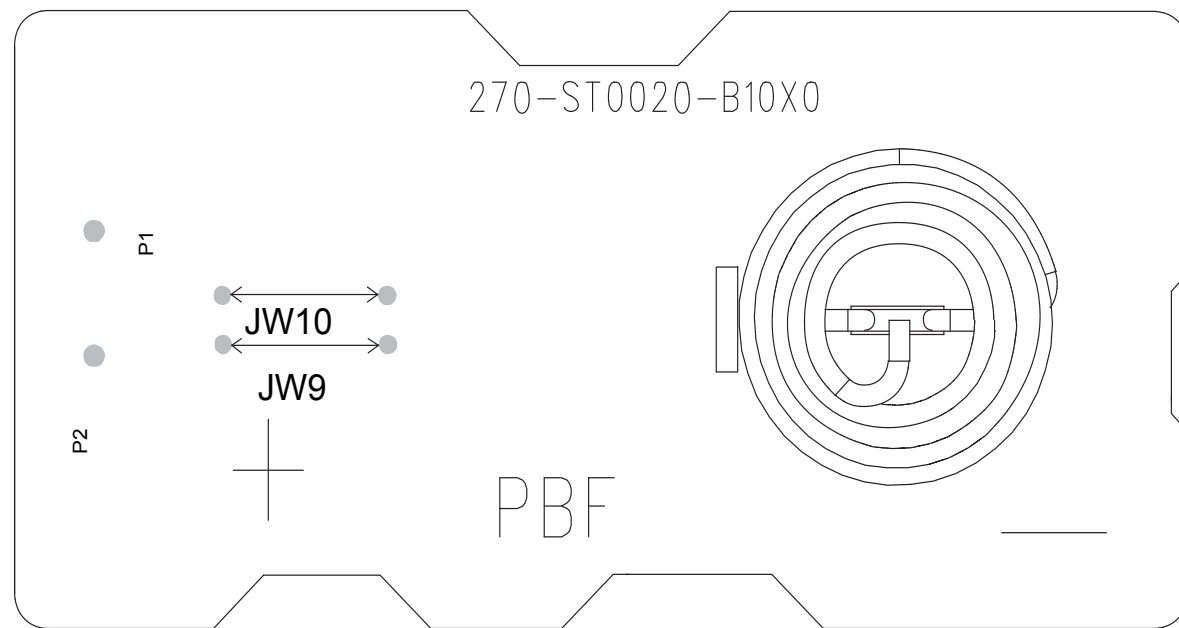
(reverse side)



# <Battery board R>

(Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade))

(forward side)



(reverse side)

